RENESAS

3851 Group (Built-in 24 KB or more ROM) SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

DESCRIPTION

The 3851 group (built-in 24 KB or more ROM) is the 8-bit microcomputer based on the 740 family core technology.

The 3851 group (built-in 24 KB or more ROM) is designed for the household products and office automation equipment and includes serial I/O functions, 8-bit timer, I²C-BUS interface, and A-D converter.

FEATURES

Clock generating circuit Built-in 2 circuits
(connect to external ceramic resonator or quartz-crystal oscillator)
Power source voltage
In high-speed mode 4.0 to 5.5 V
(at 8 MHz oscillation frequency)
In middle-speed mode 2.7 to 5.5 V
(at 8 MHz oscillation frequency)
In low-speed mode 2.7 to 5.5 V
(at 32 kHz oscillation frequency)
Power dissipation
In high-speed mode
(at 8 MHz oscillation frequency, at 5 V power source voltage)
In low-speed mode
Except M38517F8FP/SP 60 µW
M38517F8FP/SP 450 μW
(at 32 kHz oscillation frequency, at 3 V power source voltage)
● Operating temperature range–20 to 85°C

APPLICATION

Office automation equipment, FA equipment, Household products, Consumer electronics, etc.

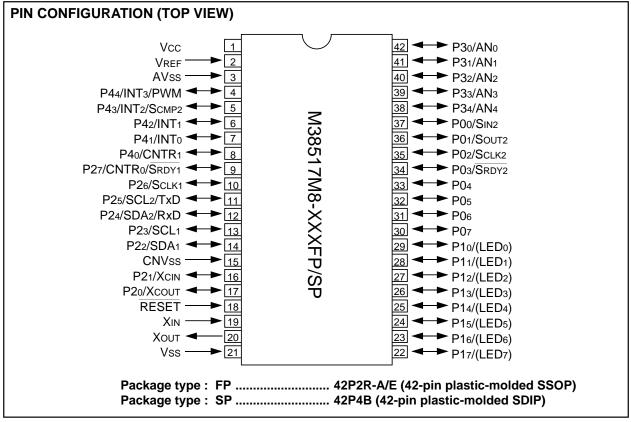


Fig. 1 M38517M8-XXXFP/SP pin configuration

FUNCTIONAL BLOCK

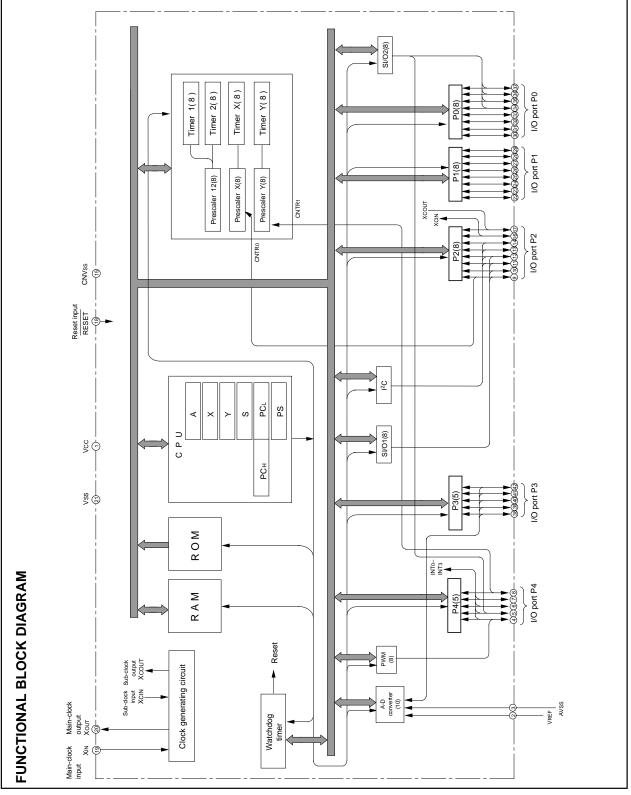


Fig.2 Functional block diagram

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Table 1 Pin description

Pin	Name	Functions	Function except a port function		
Vcc, Vss	Power source	•Apply voltage of 2.7 V – 5.5 V to Vcc, and 0 V to Vss.			
CNVss	CNVss input	•This pin controls the operation mode of the chip.			
		 Normally connected to Vss. 			
Vref	Reference voltage input	•Reference voltage input pin for A-D converter.			
AVss	Analog power	 Analog power source input pin for A-D converter. 			
	source input	•Connect to Vss.			
RESET	Reset input	•Reset input pin for active "L".			
Xin	Clock input	•Input and output pins for the clock generating circuit.			
Хоит	Olask sytext	•Connect a ceramic resonator or quartz-crystal oscillator the oscillation frequency.	between the XIN and XOUT pins to set		
2001	Clock output	•When an external clock is used, connect the clock sou pin open.	rce to the XIN pin and leave the XOUT		
P00/SIN2	I/O port P0	•8-bit CMOS I/O port.	Serial I/O2 function pin		
P01/SOUT2		•I/O direction register allows each pin to be individually			
P02/SCLK2		programmed as either input or output.			
P03/SRDY2		•CMOS compatible input level.			
P04–P07	-	•CMOS 3-state output structure.			
P10-P17	I/O port P1	•P10 to P17 (8 bits) are enabled to output large current for LED drive.			
P20/XCOUT	I/O port P2	•8-bit CMOS I/O port.	Sub-clock generating circuit I/O		
P21/XCIN		•I/O direction register allows each pin to be individually	pins (connect a resonator)		
P22/SDA1		programmed as either input or output.	• I ² C-BUS interface function pins		
P23/SCL1		•CMOS compatible input level.			
P24/SDA2/RxD		•P22 to P25 can be switched between CMOS compatible input level or SMBUS input level in the I ² C-BUS inter-	• I ² C-BUS interface function pin/		
P25/SCL2/TxD		face function.	Serial I/O1 function pins		
P26/SCLK1		•P20, P21, P24 to P27: CMOS3-state output structure.	Serial I/O1 function pin		
P27/CNTR0/ SRDY1		•P24, P25: N-channel open-drain structure in the I ² C-BUS interface function.	Serial I/O1 function pin/Timer X function pin		
		•P22, P23: N-channel open-drain structure.			
P30/AN0-	I/O port P3	•8-bit CMOS I/O port with the same function as port P0.	 A-D converter input pin 		
P34/AN4		•CMOS compatible input level.			
		•CMOS 3-state output structure.			
P40/CNTR1	I/O port P4	•8-bit CMOS I/O port with the same function as port P0.	Timer Y function pin		
P41/INT0		•CMOS compatible input level.	Interrupt input pins		
P42/INT1		•CMOS 3-state output structure.			
P43/INT2/SCMP2			Interrupt input pin		
			SCMP2 output pin		
P44/INT3/PWM	1		Interrupt input pin		
			PWM output pin		



PART NUMBERING

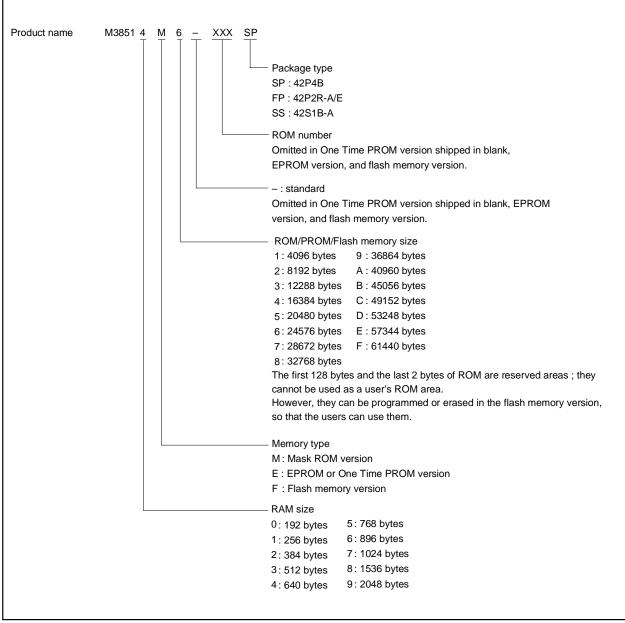


Fig. 3 Part numbering



GROUP EXPANSION

Renesas plans to expand the 3851 group (built-in 24 KB or more ROM) as follows.

Memory Type

Support for mask ROM, One Time PROM, and flash memory versions.

Memory Size

Flash memory size	32 K bytes
Mask ROM size	24 K to 32 K bytes
One Time PROM size	24 K bytes
RAM size	640 to 1 K bytes



42P4B	
42P2R-A/E	42-pin plastic-molded SSOP
42S1B-A	. 42-pin shrink ceramic DIP (EPROM version)

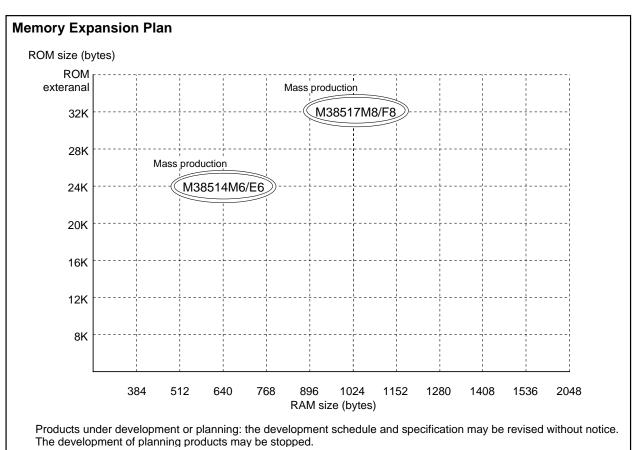


Fig. 4 Memory expansion plan

Currently planning products are listed below.

Table 2 Support products

Product name	ROM size (bytes) ROM size for User in ()	RAM size (bytes)	Package	Remarks
M38514M6-XXXSP				Mask ROM version
M38514E6-XXXSP			42P4B	One Time PROM version
M38514E6SP	04570			One Time PROM version (blank)
M38514E6SS	24576 (24446)	640	42S1B-A	EPROM version
M38514M6-XXXFP				Mask ROM version
M38514E6-XXXFP			42P2R-A/E	One Time PROM version
M38514E6FP				One Time PROM version (blank)

Table 3 3851 group (built-in 16 KB ROM) and 3851 group (built-in 24 KB or

more ROM) corresponding products					
3851 group (built-in 16 KB ROM)	3851 group (built-in 24 KB or more ROM)				
M38513M4-XXXFP/SP	M38514M6-XXXFP/SP				
M38513E4-XXXFP/SP	M38514E6-XXXFP/SP				
M38513E4FP/SP	M38514E6FP/SP				
M38513E4SS	M38514E6SS				
	M38517M8-XXXFP/SP				
	M38517F8FP/SP				

Table 4 Differences between 3851 group (built-in 16 KB ROM) and 3851 group (built-in 24 KB or more ROM)

	3851 group (built-in 16 KB ROM)	3851 group (built-in 24 KB or more ROM)
Serial I/O	1: Serial I/O	2: Serial I/O1 (UART or Clock-synchronized)
	(UART or Clock-synchronized)	Serial I/O2 (Clock-synchronized)
A-D converter	Unserviceable in low-speed mode	Serviceable in low-speed mode
Large current port	5: P13–P17	8: P10–P17

Notes on differences between 3851 group (built-in 16 KB ROM), 3851 group (built-in 24 KB or more ROM)

(1) The absolute maximum ratings of 3851 group (built-in 24 KB or more ROM) is smaller than that of 3851 group (built-in 16 KB ROM).

•Power source voltage Vcc = -0.3 to 6.5 V

•CNVss input voltage

VI = -0.3 to Vcc +0.3 V (M38514M6, M38517M8)

VI = -0.3 to 6.5 V (M38517F8)

- (2) The oscillation circuit constants of XIN-XOUT, XCIN-XCOUT may be some differences between 3851 group (built-in 16 KB ROM) and 3851 group (built-in 24 KB or more ROM).
- (3) Do not write any data to the reserved area and the reserved bit. (Do not change the contents after reset.)
- (4) Fix bit 3 of the CPU mode register to "1".
- (5) Be sure to perform the termination of unused pins.

FUNCTIONAL DESCRIPTION CENTRAL PROCESSING UNIT (CPU)

The 3851 group uses the standard 740 Family instruction set. Refer to the table of 740 Family addressing modes and machine instructions or the 740 Family Software Manual for details on the instruction set.

Machine-resident 740 Family instructions are as follows: The FST and SLW instructions cannot be used.

The STP, WIT, MUL, and DIV instructions can be used.

[Accumulator (A)]

The accumulator is an 8-bit register. Data operations such as data transfer, etc., are executed mainly through the accumulator.

[Index Register X (X)]

The index register X is an 8-bit register. In the index addressing modes, the value of the OPERAND is added to the contents of register X and specifies the real address.

[Index Register Y (Y)]

The index register Y is an 8-bit register. In partial instruction, the value of the OPERAND is added to the contents of register Y and specifies the real address.

[Stack Pointer (S)]

The stack pointer is an 8-bit register used during subroutine calls and interrupts. This register indicates start address of stored area (stack) for storing registers during subroutine calls and interrupts. The low-order 8 bits of the stack address are determined by the contents of the stack pointer. The high-order 8 bits of the stack address are determined by the stack page selection bit. If the stack page selection bit is "0", the high-order 8 bits becomes "0016". If the stack page selection bit is "1", the high-order 8 bits becomes "0116".

The operations of pushing register contents onto the stack and popping them from the stack are shown in Figure 6.

Store registers other than those described in Figure 6 with program when the user needs them during interrupts or subroutine calls.

[Program Counter (PC)]

The program counter is a 16-bit counter consisting of two 8-bit registers PCH and PCL. It is used to indicate the address of the next instruction to be executed.

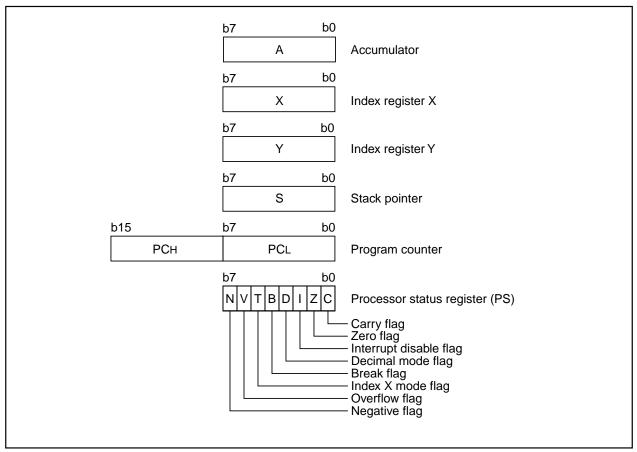


Fig. 5 740 Family CPU register structure



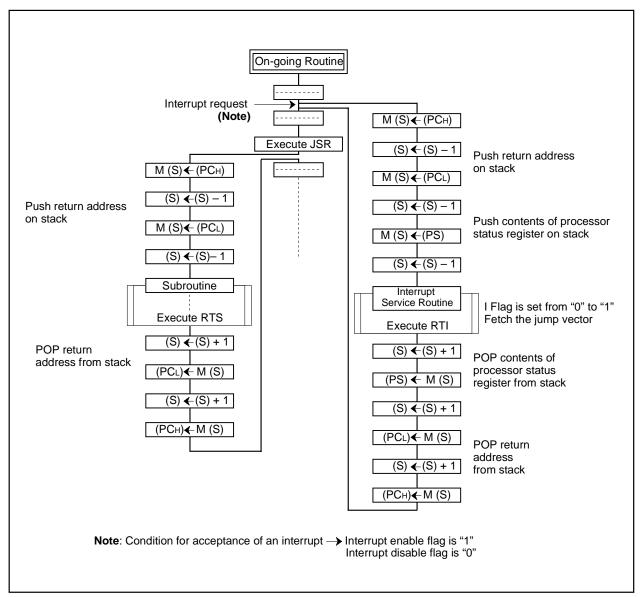


Fig. 6 Register push and pop at interrupt generation and subroutine call

	Push instruction to stack	Pop instruction from stack
Accumulator	PHA	PLA
Processor status register	PHP	PLP



[Processor status register (PS)]

The processor status register is an 8-bit register consisting of 5 flags which indicate the status of the processor after an arithmetic operation and 3 flags which decide MCU operation. Branch operations can be performed by testing the Carry (C) flag, Zero (Z) flag, Overflow (V) flag, or the Negative (N) flag. In decimal mode, the Z, V, N flags are not valid.

•Bit 0: Carry flag (C)

The C flag contains a carry or borrow generated by the arithmetic logic unit (ALU) immediately after an arithmetic operation. It can also be changed by a shift or rotate instruction.

•Bit 1: Zero flag (Z)

The Z flag is set if the result of an immediate arithmetic operation or a data transfer is "0", and cleared if the result is anything other than "0".

•Bit 2: Interrupt disable flag (I)

The I flag disables all interrupts except for the interrupt generated by the BRK instruction.

Interrupts are disabled when the I flag is "1".

•Bit 3: Decimal mode flag (D)

The D flag determines whether additions and subtractions are executed in binary or decimal. Binary arithmetic is executed when this flag is "0"; decimal arithmetic is executed when it is "1". Decimal correction is automatic in decimal mode. Only the ADC and SBC instructions can be used for decimal arithmetic.

•Bit 4: Break flag (B)

The B flag is used to indicate that the current interrupt was generated by the BRK instruction. The BRK flag in the processor status register is always "0". When the BRK instruction is used to generate an interrupt, the processor status register is pushed onto the stack with the break flag set to "1".

•Bit 5: Index X mode flag (T)

When the T flag is "0", arithmetic operations are performed between accumulator and memory. When the T flag is "1", direct arithmetic operations and direct data transfers are enabled between memory locations.

•Bit 6: Overflow flag (V)

The V flag is used during the addition or subtraction of one byte of signed data. It is set if the result exceeds +127 to -128. When the BIT instruction is executed, bit 6 of the memory location operated on by the BIT instruction is stored in the overflow flag. t 7. Negative flag. (N)

•Bit 7: Negative flag (N)

The N flag is set if the result of an arithmetic operation or data transfer is negative. When the BIT instruction is executed, bit 7 of the memory location operated on by the BIT instruction is stored in the negative flag.

Table 6 Set and clear instructions of each bit of processor status register

	C flag	Z flag	l flag	D flag	B flag	T flag	V flag	N flag
Set instruction	SEC	-	SEI	SED	-	SET	-	-
Clear instruction	CLC	_	CLI	CLD	—	CLT	CLV	-



[CPU Mode Register (CPUM)] 003B16

The CPU mode register contains the stack page selection bit, etc. The CPU mode register is allocated at address 003B16.

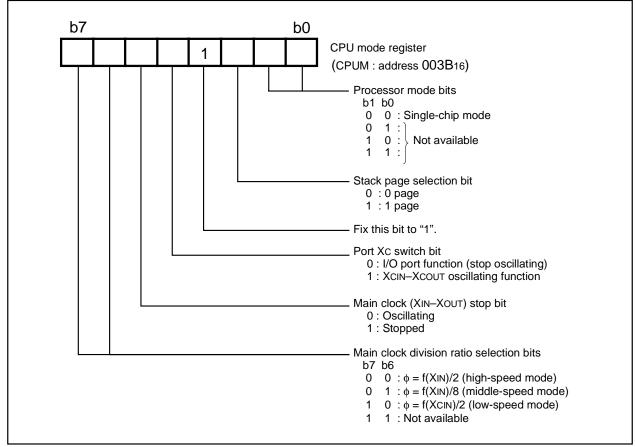


Fig. 7 Structure of CPU mode register



MEMORY Special Function Register (SFR) Area

The Special Function Register area in the zero page contains control registers such as I/O ports and timers.

RAM

RAM is used for data storage and for stack area of subroutine calls and interrupts.

ROM

The first 128 bytes and the last 2 bytes of ROM are reserved for device testing and the rest is user area for storing programs.

Interrupt Vector Area

The interrupt vector area contains reset and interrupt vectors.

Zero Page

Access to this area with only 2 bytes is possible in the zero page addressing mode.

Special Page

Access to this area with only 2 bytes is possible in the special page addressing mode.

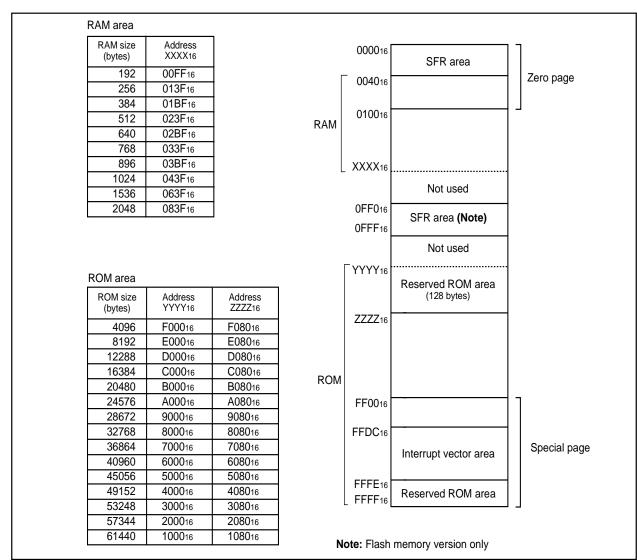


Fig. 8 Memory map diagram



000016	Port P0 (P0)	002016	Prescaler 12 (PRE12)
00116	Port P0 direction register (P0D)	002116	Timer 1 (T1)
00216	Port P1 (P1)	002216	Timer 2 (T2)
000316	Port P1 direction register (P1D)	002316	Timer XY mode register (TM)
00416	Port P2 (P2)	002416	Prescaler X (PREX)
000516	Port P2 direction register (P2D)	002516	Timer X (TX)
00616	Port P3 (P3)	002616	Prescaler Y (PREY)
00716	Port P3 direction register (P3D)	002716	Timer Y (TY)
00816	Port P4 (P4)	002816	Timer count source selection register (TCSS)
00916	Port P4 direction register (P4D)	002916	
00A16		002A16	
00B16		002B16	I ² C data shift register (S0)
00C16		002C16	I ² C address register (S0D)
00D16		002D16	I ² C status register (S1)
000E16		002E16	I ² C control register (S1D)
000F16		002F16	I ² C clock control register (S2)
01016		003016	I ² C start/stop condition control register (S2D)
001116		003116	Reserved *
01216	Reserved *	003216	
01316	Reserved *	003316	
01416	Reserved *	003416	A-D control register (ADCON)
01516	Serial I/O2 control register 1 (SIO2CON1)	003516	A-D conversion low-order register (ADL)
01616	Serial I/O2 control register 2 (SIO2CON2)	003616	A-D conversion high-order register (ADH)
01716	Serial I/O2 register (SIO2)	003716	Reserved *
01816	Transmit/Receive buffer register (TB/RB)	003816	MISRG
01916	Serial I/O1 status register (SIOSTS)	003916	Watchdog timer control register (WDTCON)
01A16	Serial I/O1 control register (SIOCON)	003A16	Interrupt edge selection register (INTEDGE)
001B16	UART control register (UARTCON)	003B16	CPU mode register (CPUM)
001C16	Baud rate generator (BRG)	003C16	Interrupt request register 1 (IREQ1)
01D16	PWM control register (PWMCON)	003D16	Interrupt request register 2 (IREQ2)
01E16	PWM prescaler (PREPWM)	003E16	Interrupt control register 1 (ICON1)
001F16	PWM register (PWM)	003F16	Interrupt control register 2 (ICON2)
		0FFD16	Reserved
		0FFE16	Flash memory control register 1 (FMCR)
		0FFF16	Reserved

 $\boldsymbol{\ast}$ Reserved : Do not write any data to this addresses, because these areas are reserved.

Fig. 9 Memory map of special function register (SFR)



I/O PORTS

The I/O ports have direction registers which determine the input/ output direction of each individual pin. Each bit in a direction register corresponds to one pin, and each pin can be set to be input port or output port.

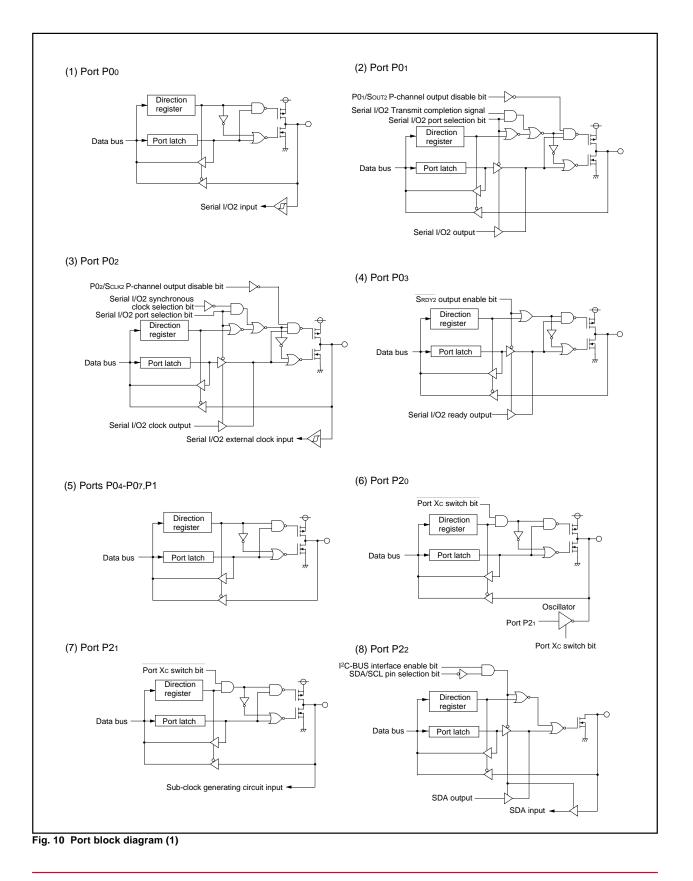
When "0" is written to the bit corresponding to a pin, that pin becomes an input pin. When "1" is written to that bit, that pin becomes an output pin.

If data is read from a pin which is set to output, the value of the port output latch is read, not the value of the pin itself. Pins set to input are floating. If a pin set to input is written to, only the port output latch is written to and the pin remains floating.

Table 7 I/O port function

Pin	Name	Input/Output	I/O Structure	Non-Port Function	Related SFRs	Ref.No
P00/SIN2 P01/SOUT2 P02/SCLK2 P03/SRDY2	Port P0		CMOS compatible	Serial I/O2 function I/O	Serial I/O2 control register	(1) (2) (3) (4)
P04-P07			CMOS 3-state output			(5)
P10-P17	Port P1					(0)
P20/XCOUT P21/XCIN				Sub-clock generating circuit	CPU mode register	(6) (7)
P22/SDA1 P23/SCL1			CMOS compatible input level CMOS/SMBUS input level (when selecting I ² C- BUS interface function) N-channel open-drain output	I ² C-BUS interface function I/O	I ² C control register	(8) (9)
P24/SDA2/RxD P25/SCL2/TxD	Port P2	Input/output, individual bits	CMOS compatible input level CMOS/SMBUS input level (when selecting I ² C- BUS interface function) CMOS 3-state output N-channel open-drain output (when selecting I ² C- BUS interface function)	I ² C-BUS interface function I/O Serial I/O1 function I/O	I ² C control register Serial I/O1 control register	(10) (11)
P26/SCLK1				Serial I/O1 function I/O	Serial I/O1 control register	(12)
P27/CNTR0/SRDY1				Serial I/O1 function I/O Timer X function I/O	Serial I/O1 control register Timer XY mode register	(13)
P30/AN0-P34/AN4	Port P3			A-D conversion input	A-D control register	(14)
P40/CNTR1			CMOS compatible	Timer Y function I/O	Timer XY mode register	(15)
P41/INT0 P42/INT1			input level CMOS 3-state	External interrupt input	Interrupt edge selection register	(16)
P43/INT2/SCMP2	Port P4		output	External interrupt input SCMP2 output	Interrupt edge selection register Serial I/O2 control register	(17)
P44/INT3/PWM				External interrupt input PWM output	Interrupt edge selection register PWM control register	(18)

Note: When reading bit 5, 6, or 7 of ports P3 and P4, the contents are undefined.



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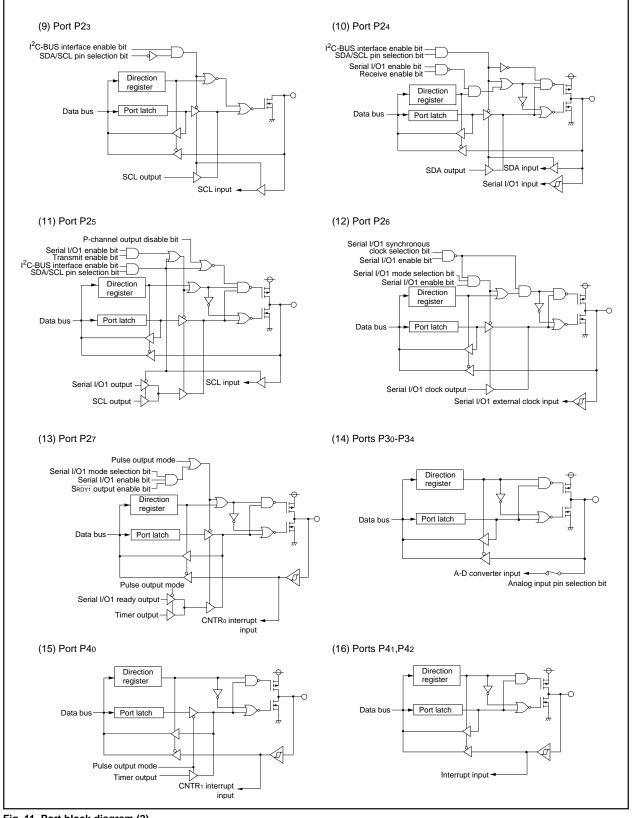


Fig. 11 Port block diagram (2)

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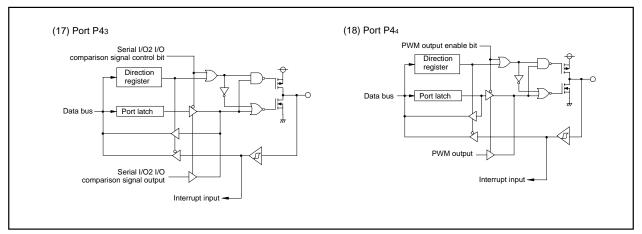


Fig. 12 Port block diagram (3)

INTERRUPTS

Interrupts occur by 17 : seven external, nine internal, and one software.

Interrupt Control

Each interrupt is controlled by an interrupt request bit, an interrupt enable bit, and the interrupt disable flag except for the software interrupt set by the BRK instruction. An interrupt occurs if the corresponding interrupt request and enable bits are "1" and the interrupt disable flag is "0".

Interrupt enable bits can be set or cleared by software.

Interrupt request bits can be cleared by software, but cannot be set by software.

The BRK instruction cannot be disabled with any flag or bit. The I (interrupt disable) flag disables all interrupts except the BRK instruction interrupt.

When several interrupts occur at the same time, the interrupts are received according to priority.

Interrupt Operation

By acceptance of an interrupt, the following operations are automatically performed:

- 1. The contents of the program counter and the processor status register are automatically pushed onto the stack.
- The interrupt disable flag is set and the corresponding interrupt request bit is cleared.
- 3. The interrupt jump destination address is read from the vector table into the program counter.

Notes

When setting the followings, the interrupt request bit may be set to "1".

•When setting external interrupt active edge

Related register: Interrupt edge selection register (address 003A16) Timer XY mode register (address 002316)

•When switching interrupt sources of an interrupt vector address where two or more interrupt sources are allocated

Related register: Interrupt edge selection register (address 003A16) When not requiring for the interrupt occurrence synchronized with these setting, take the following sequence.

- (1) Set the corresponding interrupt enable bit to "0" (disabled).
- (2) Set the interrupt edge select bit or the interrupt source select bit.
- (3) Set the corresponding interrupt request bit to "0" after 1 or more instructions have been executed.
- (4) Set the corresponding interrupt enable bit to "1" (enabled).



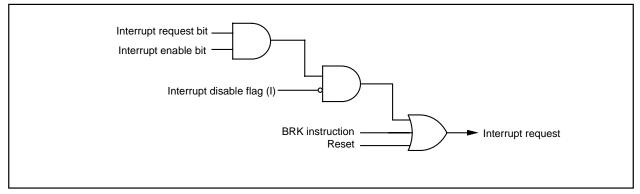
Interrupt Source	Priority	Vector Addresses (Note 1)		Interrupt Request	Remarks	
Interrupt Source	FIIOIIty	High	Low	Generating Conditions	Remarks	
Reset (Note 2)	1	FFFD16	FFFC16	At reset	Non-maskable	
INT ₀	2	FFFB16	FFFA16	At detection of either rising or falling edge of INTo input	External interrupt (active edge selectable)	
SCL, SDA	3	FFF916	FFF816	At detection of either rising or falling edge of SCL or SDA input	External interrupt (active edge selectable)	
INT1	4	FFF716	FFF616	At detection of either rising or falling edge of INT1 input	External interrupt (active edge selectable)	
INT2	5	FFF516	FFF416	At detection of either rising or falling edge of INT2 input	External interrupt (active edge selectable)	
INT3				At detection of either rising or falling edge of INT3 input	External interrupt (active edge selectable)	
Serial I/O2	6	FFF316	FFF216	At completion of serial I/O2 data reception/transmission	Switch by Serial I/O2/INT3 interrupt source bit	
l ² C	7	FFF116	FFF016	At completion of data transfer		
Timer X	8	FFEF16	FFEE16	At timer X underflow		
Timer Y	9	FFED16	FFEC16	At timer Y underflow		
Timer 1	10	FFEB16	FFEA16	At timer 1 underflow	STP release timer underflow	
Timer 2	11	FFE916	FFE816	At timer 2 underflow		
Serial I/O1 reception	12	FFE716	FFE616	At completion of serial I/O1 data reception	Valid when serial I/O is selected	
Serial I/O1 transmission	13	FFE516	FFE416	At completion of serial I/O1 transfer shift or when transmission buffer is empty	Valid when serial I/O is selected	
CNTR ₀	14	FFE316	FFE216	At detection of either rising or falling edge of CNTRo input	External interrupt (active edge selectable)	
CNTR1	15	FFE116	FFE016	At detection of either rising or falling edge of CNTR1 input	External interrupt (active edge selectable)	
A-D converter	16	FFDF16	FFDE16	At completion of A-D conversion		
BRK instruction	17	FFDD16	FFDC16	At BRK instruction execution	Non-maskable software interrup	

Table 8 Interrupt vector addresses and priority

Notes 1: Vector addresses contain interrupt jump destination addresses.

2: Reset function in the same way as an interrupt with the highest priority.







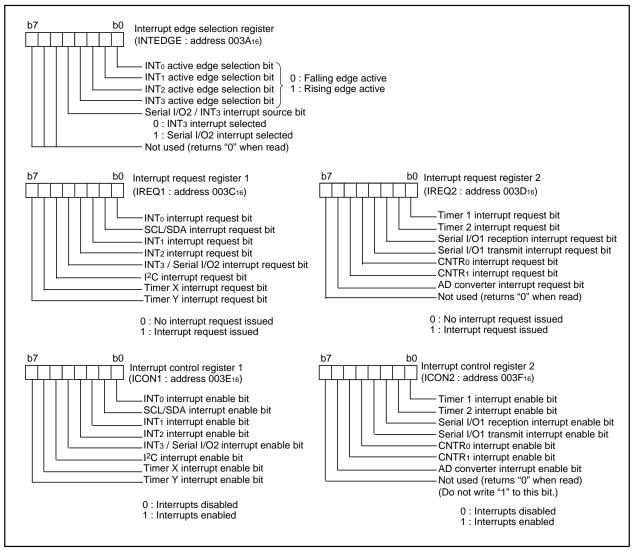


Fig. 14 Structure of interrupt-related registers

TIMERS

The 3851 group (built-in 24 KB or more ROM) has four timers: timer X, timer Y, timer 1, and timer 2.

The division ratio of each timer or prescaler is given by 1/(n + 1), where n is the value in the corresponding timer or prescaler latch. All timers are count down. When the timer reaches "0016", an underflow occurs at the next count pulse and the corresponding timer latch is reloaded into the timer and the count is continued. When a timer underflows, the interrupt request bit corresponding to that timer is set to "1".

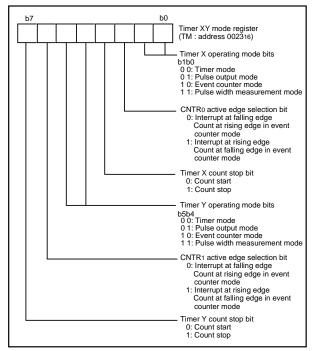


Fig. 15 Structure of timer XY mode register

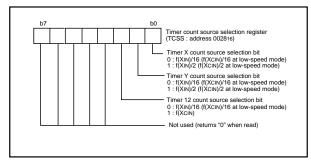


Fig. 16 Structure of timer count source selection register

Timer 1 and Timer 2

The count source of prescaler 12 is the oscillation frequency which is selected by timer 12 count source selection bit. The output of prescaler 12 is counted by timer 1 and timer 2, and a timer underflow sets the interrupt request bit.

Timer X and Timer Y

Timer X and Timer Y can each select in one of four operating modes by setting the timer XY mode register.

(1) Timer Mode

The timer counts the count source selected by Timer count source selection bit.

(2) Pulse Output Mode

The timer counts the count source selected by Timer count source selection bit. Whenever the contents of the timer reach "0016", the signal output from the CNTR0 (or CNTR1) pin is inverted. If the CNTR0 (or CNTR1) active edge selection bit is "0", output begins at " H".

If it is "1", output starts at "L". When using a timer in this mode, set the corresponding port P27 (or port P40) direction register to output mode.

(3) Event Counter Mode

Operation in event counter mode is the same as in timer mode, except that the timer counts signals input through the CNTR0 or CNTR1 pin.

When the CNTR0 (or CNTR1) active edge selection bit is "0", the rising edge of the CNTR0 (or CNTR1) pin is counted.

When the CNTR0 (or CNTR1) active edge selection bit is "1", the falling edge of the CNTR0 (or CNTR1) pin is counted.

(4) Pulse Width Measurement Mode

If the CNTR0 (or CNTR1) active edge selection bit is "0", the timer counts the selected signals by the count source selection bit while the CNTR0 (or CNTR1) pin is at "H". If the CNTR0 (or CNTR1) active edge selection bit is "1", the timer counts it while the CNTR0 (or CNTR1) pin is at "L".

The count can be stopped by setting "1" to the timer X (or timer Y) count stop bit in any mode. The corresponding interrupt request bit is set each time a timer underflows.

Note

When switching the count source by the timer 12, X and Y count source bits, the value of timer count is altered in unconsiderable amount owing to generating of a thin pulses in the count input signals.

Therefore, select the timer count source before set the value to the prescaler and the timer.

When timer X/timer Y underflow while executing the instruction which sets "1" to the timer X/timer Y count stop bits, the timer X/ timer Y interrupt request bits are set to "1". Timer X/Timer Y interrupts are received if these interrupts are enabled at this time. The timing which interrupt is accepted has a case after the instruction which sets "1" to the count stop bit, and a case after the next instruction according to the timing of the timer underflow. When this interrupt is unnecessary, set "0" (disabled) to the interrupt enable bit and then set "1" to the count stop bit.



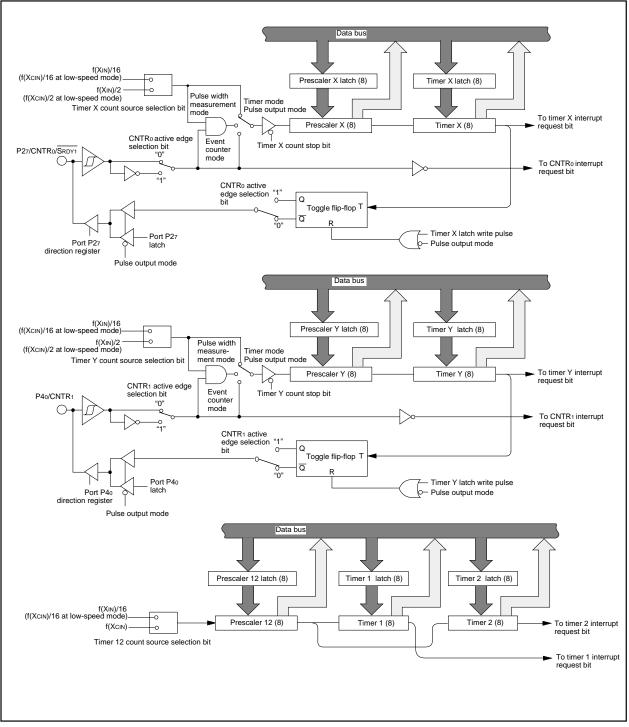


Fig. 17 Block diagram of timer X, timer Y, timer 1, and timer 2

SERIAL I/O SERIAL I/O1

Serial I/O1 can be used as either clock synchronous or asynchronous (UART) serial I/O. A dedicated timer is also provided for baud rate generation.

(1) Clock Synchronous Serial I/O Mode

Clock synchronous serial I/O mode can be selected by setting the serial I/O1 mode selection bit of the serial I/O1 control register (bit 6 of address 001A16) to "1".

For clock synchronous serial I/O, the transmitter and the receiver must use the same clock. If an internal clock is used, transfer is started by a write signal to the TB/RB.

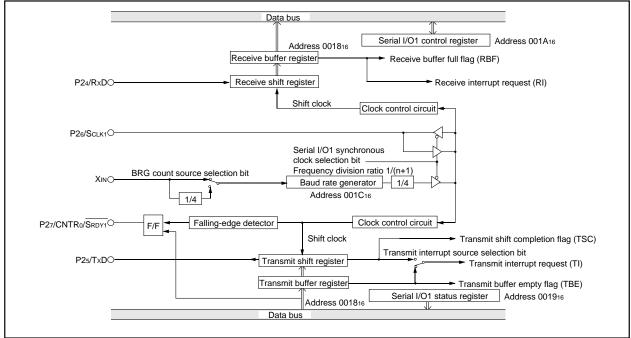


Fig. 18 Block diagram of clock synchronous serial I/O1

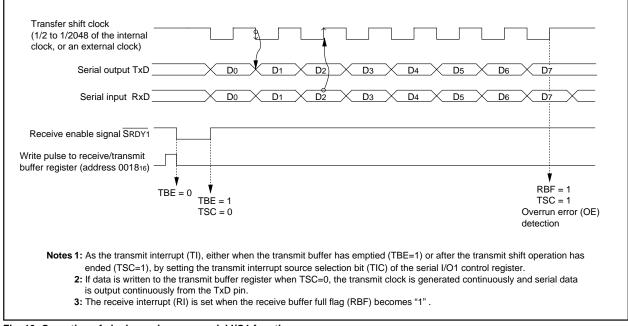


Fig. 19 Operation of clock synchronous serial I/O1 function

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(2) Asynchronous Serial I/O (UART) Mode

Clock asynchronous serial I/O mode (UART) can be selected by clearing the serial I/O1 mode selection bit (b6) of the serial I/O1 control register to "0".

Eight serial data transfer formats can be selected, and the transfer formats used by a transmitter and receiver must be identical.

The transmit and receive shift registers each have a buffer, but the

two buffers have the same address in memory. Since the shift register cannot be written to or read from directly, transmit data is written to the transmit buffer register, and receive data is read from the receive buffer register.

The transmit buffer register can also hold the next data to be transmitted, and the receive buffer register can hold a character while the next character is being received.

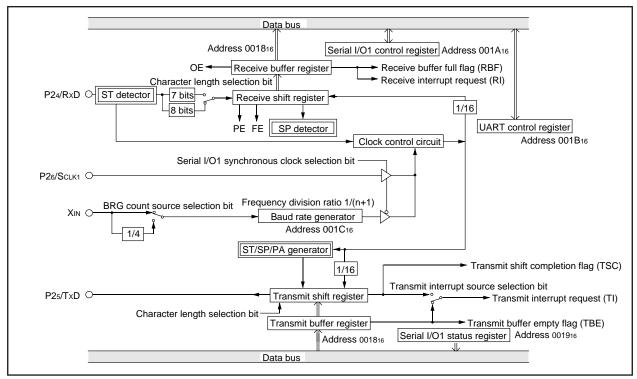


Fig. 20 Block diagram of UART serial I/O1



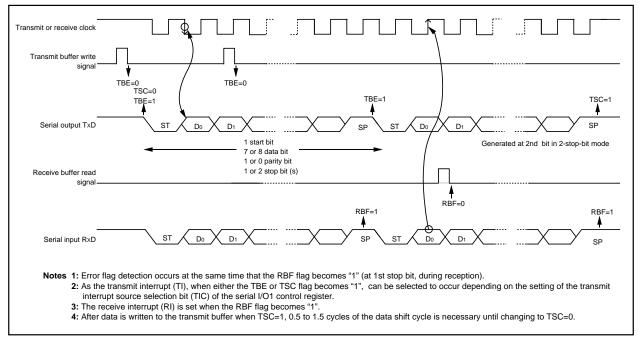


Fig. 21 Operation of UART serial I/O1 function

[Transmit Buffer Register/Receive Buffer Register (TB/RB)] 001816

The transmit buffer register and the receive buffer register are located at the same address. The transmit buffer is write-only and the receive buffer is read-only. If a character bit length is 7 bits, the MSB of data stored in the receive buffer is "0".

[Serial I/O1 Status Register (SIOSTS)] 001916

The read-only serial I/O1 status register consists of seven flags (bits 0 to 6) which indicate the operating status of the serial I/O1 function and various errors.

Three of the flags (bits 4 to 6) are valid only in UART mode.

The receive buffer full flag (bit 1) is cleared to "0" when the receive buffer register is read.

If there is an error, it is detected at the same time that data is transferred from the receive shift register to the receive buffer register, and the receive buffer full flag is set. A write to the serial I/O1 status register clears all the error flags OE, PE, FE, and SE (bit 3 to bit 6, respectively). Writing "0" to the serial I/O1 enable bit SIOE (bit 7 of the serial I/O1 control register) also clears all the status flags, including the error flags.

Bits 0 to 6 of the serial I/O1 status register are initialized to "0" at reset, but if the transmit enable bit (bit 4) of the serial I/O1 control register has been set to "1", the transmit shift completion flag (bit 2) and the transmit buffer empty flag (bit 0) become "1".

[Serial I/O1 Control Register (SIOCON)] 001A16

The serial I/O1 control register consists of eight control bits for the serial I/O1 function.

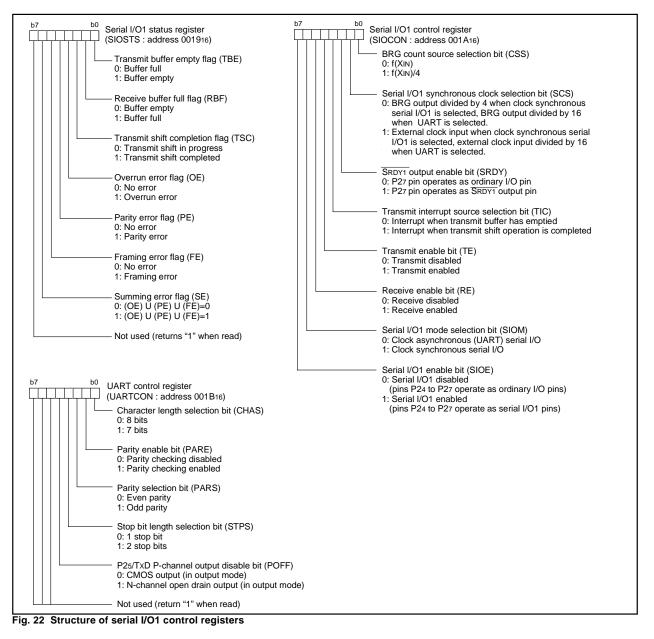
[UART Control Register (UARTCON)] 001B16

The UART control register consists of four control bits (bits 0 to 3) which are valid when asynchronous serial I/O is selected and set the data format of an data transfer and one bit (bit 4) which is always valid and sets the output structure of the P25/TxD pin.

[Baud Rate Generator (BRG)] 001C16

The baud rate generator determines the baud rate for serial transfer.

The baud rate generator divides the frequency of the count source by 1/(n + 1), where n is the value written to the baud rate generator.



■Notes on serial I/O1

- When using the serial I/O1, clear the I²C-BUS interface enable bit to "0" or the SDA/SCL interrupt pin selection bit to "0".
- When setting the transmit enable bit of serial I/O1 to "1", the serial I/O1 transmit interrupt request bit is automatically set to "1". When not requiring the interrupt occurrence synchronized with the transmission enabled, take the following sequence.
 - (1) Set the serial I/O1 transmit interrupt enable bit to "0" (disabled).
 - (2) Set the transmit enable bit to "1".
 - (3) Set the serial I/O1 transmit interrupt request bit to "0" after 1 or more instructions have been executed.
 - (4) Set the serial I/O1 transmit interrupt enable bit to "1" (enabled).

•SERIAL I/O2

The serial I/O2 can be operated only as the clock synchronous type. As a synchronous clock for serial transfer, either internal clock or external clock can be selected by the serial I/O2 synchronous clock selection bit (b6) of serial I/O2 control register 1.

The internal clock incorporates a dedicated divider and permits selecting 6 types of clock by the internal synchronous clock selection bits (b2, b1, b0) of serial I/O2 control register 1.

Regarding SOUT2 and SCLK2 being output pins, either CMOS output format or N-channel open-drain output format can be selected by the P01/SOUT2, P02/SCLK2 P-channel output disable bit (b7) of serial I/O2 control register 1.

When the internal clock has been selected, a transfer starts by a write signal to the serial I/O2 register (address 001716). After completion of data transfer, the level of the SOUT2 pin goes to high impedance automatically but bit 7 of the serial I/O2 control register 2 is not set to "1" automatically.

When the external clock has been selected, the contents of the serial I/O2 register is continuously sifted while transfer clocks are input. Accordingly, control the clock externally. Note that the SOUT2 pin does not go to high impedance after completion of data transfer.

To cause the SOUT2 pin to go to high impedance in the case where the external clock is selected, set bit 7 of the serial I/O2 control register 2 to "1" when SCLK2 is "H" after completion of data transfer. After the next data transfer is started (the transfer clock falls), bit 7 of the serial I/O2 control register 2 is set to "0" and the SOUT2 pin is put into the active state.

Regardless of the internal clock to external clock, the interrupt request bit is set after the number of bits (1 to 8 bits) selected by the optional transfer bit is transferred. In case of a fractional number of bits less than 8 bits as the last data, the received data to be stored in the serial I/O2 register becomes a fractional number of bits close to MSB if the transfer direction selection bit of serial I/O2 control register 1 is LSB first, or a fractional number of bits close to LSB if the transfer direction selection bit is MSB first. For the remaining bits, the previously received data is shifted.

At transmit operation using the clock synchronous serial I/O, the SCMP2 signal can be output by comparing the state of the transmit pin SOUT2 with the state of the receive pin SIN2 in synchronization with a rise of the transfer clock. If the output level of the SOUT2 pin is equal to the input level to the SIN2 pin, "L" is output from the SCMP2 pin. If not, "H" is output. At this time, an INT2 interrupt request can also be generated. Select a valid edge by bit 2 of the interrupt edge selection register (address 003A16).

[Serial I/O2 Control Registers 1, 2 (SIO2CON1 / SIO2CON2)] 001516, 001616

The serial I/O2 control registers 1 and 2 are containing various selection bits for serial I/O2 control as shown in Figure 23.

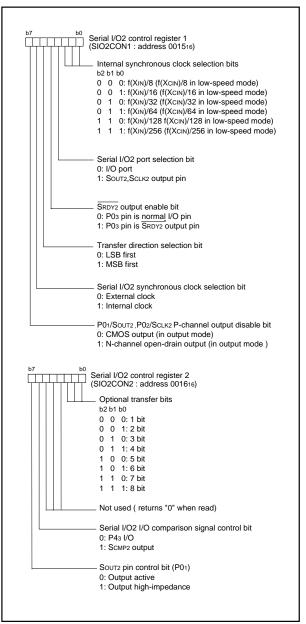


Fig. 23 Structure of Serial I/O2 control registers 1, 2

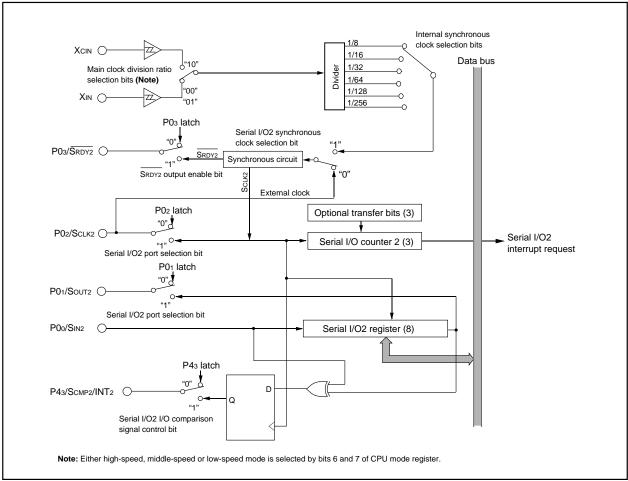
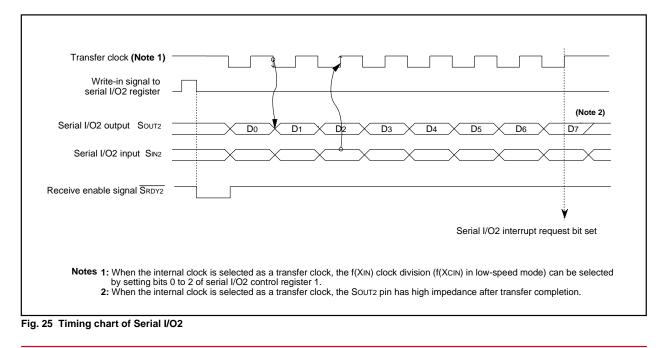


Fig. 24 Block diagram of Serial I/O2



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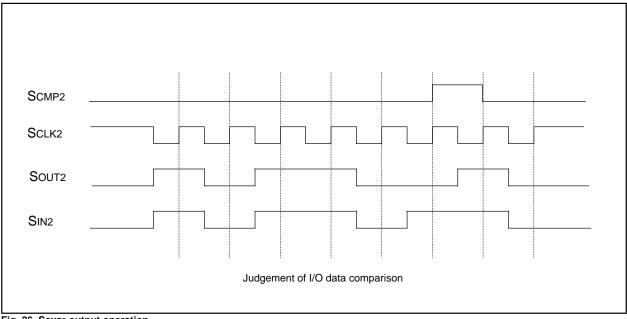


Fig. 26 SCMP2 output operation

MULTI-MASTER I²C-BUS INTERFACE

The multi-master I²C-BUS interface is a serial communications circuit, conforming to the Philips I²C-BUS data transfer format. This interface, offering both arbitration lost detection and a synchronous functions, is useful for the multi-master serial communications.

Figure 27 shows a block diagram of the multi-master I²C-BUS interface and Table 9 lists the multi-master I²C-BUS interface functions.

This multi-master I²C-BUS interface consists of the I²C address register, the I²C data shift register, the I²C clock control register, the I²C control register, the I²C status register, the I²C start/stop condition control register and other control circuits.

When using the multi-master I^2C-BUS interface, set 1 MHz or more to $\boldsymbol{\varphi}.$

Note: Renesas Technology Corporation assumes no responsibility for infringement of any third-party's rights or originating in the use of the connection control function between the I²C-BUS interface and the ports SCL1, SCL2, SDA1 and SDA2 with the bit 6 of I²C control register (002E16).

Table 9 Multi-master I²C-BUS interface functions

ltem	Function	
Format	In conformity with Philips I ² C-BUS standard: 10-bit addressing format 7-bit addressing format High-speed clock mode Standard clock mode	
Communication mode	In conformity with Philips I ² C-BUS standard: Master transmission Master reception Slave transmission Slave reception	
SCL clock frequency	16.1 kHz to 400 kHz (at φ= 4 MHz)	

System clock $\phi = f(XIN)/2$ (high-speed mode)

 $\phi = f(XIN)/8 \text{ (middle-speed mode)}$

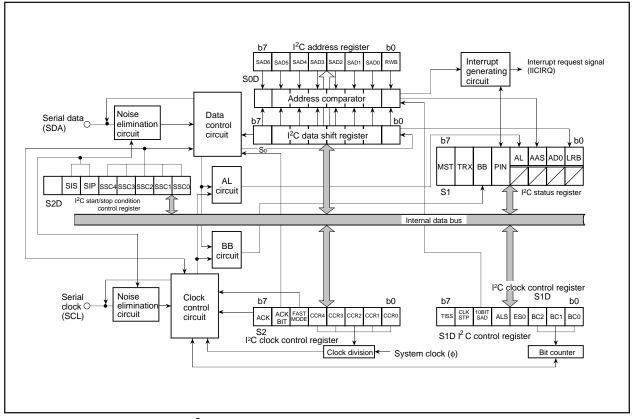


Fig. 27 Block diagram of multi-master I²C-BUS interface

* : Purchase of Renesas Technology Corporation's I²C components conveys a license under the Philips I²C Patent Rights to use these components an I²C system, provided that the system conforms to the I²C Standard Specification as defined by Philips.

[I²C Data Shift Register (S0)] 002B16

The I^2C data shift register (S0 : address 002B16) is an 8-bit shift register to store receive data and write transmit data.

When transmit data is written into this register, it is transferred to the outside from bit 7 in synchronization with the SCL clock, and each time one-bit data is output, the data of this register are shifted by one bit to the left. When data is received, it is input to this register from bit 0 in synchronization with the SCL clock, and each time one-bit data is input, the data of this register are shifted by one bit to the left. The minimum 2 machine cycles are required from the rising of the SCL clock until input to this register.

The I²C data shift register is in a write enable status only when the I²C-BUS interface enable bit (ES0 bit : bit 3 of address 002E16) of the I²C control register is "1". The bit counter is reset by a write instruction to the I²C data shift register. When both the ES0 bit and the MST bit of the I²C status register (address 002D16) are "1", the SCL is output by a write instruction to the I²C data shift register is always enabled regardless of the ES0 bit value.

[I²C Address Register (S0D)] 002C16

The I^2C address register (address 002C16) consists of a 7-bit slave address and a read/write bit. In the addressing mode, the slave address written in this register is compared with the address data to be received immediately after the START condition is detected.

•Bit 0: Read/write bit (RWB)

This is not used in the 7-bit addressing mode. In the 10-bit addressing mode, the first address data to be received is compared with the contents (SAD6 to SAD0 + RWB) of the I^2C address register.

The RWB bit is cleared to "0" automatically when the stop condition is detected.

•Bits 1 to 7: Slave address (SAD0-SAD6)

These bits store slave addresses. Regardless of the 7-bit addressing mode and the 10-bit addressing mode, the address data transmitted from the master is compared with the contents of these bits.

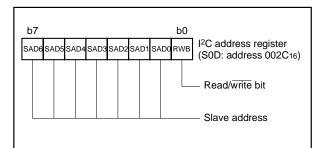


Fig. 28 Structure of I²C address register



[I²C Clock Control Register (S2)] 002F16

The I²C clock control register (address 002F16) is used to set ACK control, SCL mode and SCL frequency.

•Bits 0 to 4: SCL frequency control bits (CCR0–CCR4)

These bits control the SCL frequency. Refer to Table 10.

•Bit 5: SCL mode specification bit (FAST MODE)

This bit specifies the SCL mode. When this bit is set to "0", the standard clock mode is selected. When the bit is set to "1", the high-speed clock mode is selected.

When connecting the bus of the high-speed mode I^2 C-BUS standard (maximum 400 kbits/s), use 8 MHz or more oscillation frequency f(XIN) and 2 division clock.

•Bit 6: ACK bit (ACK BIT)

This bit sets the SDA status when an ACK clock* is generated. When this bit is set to "0", the ACK return mode is selected and SDA goes to "L" at the occurrence of an ACK clock. When the bit is set to "1", the ACK non-return mode is selected. The SDA is held in the "H" status at the occurrence of an ACK clock.

However, when the slave address agree with the address data in the reception of address data at ACK BIT = "0", the SDA is automatically made "L" (ACK is returned). If there is a disagreement between the slave address and the address data, the SDA is automatically made "H" (ACK is not returned).

*ACK clock: Clock for acknowledgment

•Bit 7: ACK clock bit (ACK)

This bit specifies the mode of acknowledgment which is an acknowledgment response of data transfer. When this bit is set to "0", the no ACK clock mode is selected. In this case, no ACK clock occurs after data transmission. When the bit is set to "1", the ACK clock mode is selected and the master generates an ACK clock each completion of each 1-byte data transfer. The device for transmitting address data and control data releases the SDA at the occurrence of an ACK clock (makes SDA "H") and receives the ACK bit generated by the data receiving device.

Note: Do not write data into the I²C clock control register during transfer. If data is written during transfer, the I²C clock generator is reset, so that data cannot be transferred normally.

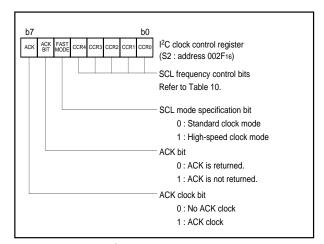


Fig. 29 Structure of I²C clock control register

Table 10	Set values of I ² C clock control register and SCL
	frequency

Setting value of CCR4–CCR0				SCL frequency (Note 1) (at ϕ = 4 MHz, unit : kHz)		
CCR4	CCR3	CCR2	CCR1	CCR0	Standard clock mode	High-speed clock mode
0	0	0	0	0	Setting disabled	Setting disabled
0	0	0	0	1	Setting disabled	Setting disabled
0	0	0	1	0	Setting disabled	Setting disabled
0	0	0	1	1	– (Note 2)	333
0	0	1	0	0	– (Note 2)	250
0	0	1	0	1	100	400 (Note 3)
0	0	1	1	0	83.3	166
:	÷	÷	÷	:	500/CCR value (Note 3)	1000/CCR value (Note 3)
1	1	1	0	1	17.2	34.5
1	1	1	1	0	16.6	33.3
1	1	1	1	1	16.1	32.3

Notes 1: Duty of SCL clock output is 50 %. The duty becomes 35 to 45 % only when the high-speed clock mode is selected and CCR value = 5 (400 kHz, at $\phi = 4$ MHz). "H" duration of the clock fluctuates from -4 to +2 machine cycles in the standard clock mode, and fluctuates from -2 to +2 machine cycles in the high-speed clock mode. In the case of negative fluctuation, the frequency does not increase because "L" duration is extended instead of "H" duration reduction.

These are value when SCL clock synchronization by the synchronous function is not performed. CCR value is the decimal notation value of the SCL frequency control bits CCR4 to CCR0.

2: Each value of SCL frequency exceeds the limit at ϕ = 4 MHz or more. When using these setting value, use ϕ of 4 MHz or less.



[I²C Control Register (S1D)] 002E16

The I²C control register (address 002E16) controls data communication format.

•Bits 0 to 2: Bit counter (BC0–BC2)

These bits decide the number of bits for the next 1-byte data to be transmitted. The l^2C interrupt request signal occurs immediately after the number of count specified with these bits (ACK clock is added to the number of count when ACK clock is selected by ACK clock bit (bit 7 of address 002F16)) have been transferred, and BC0 to BC2 are returned to "0002".

Also when a START condition is received, these bits become "0002" and the address data is always transmitted and received in 8 bits.

•Bit 3: I²C interface enable bit (ES0)

This bit enables to use the multi-master I²C-BUS interface. When this bit is set to "0", the use disable status is provided, so that the SDA and the SCL become high-impedance. When the bit is set to "1", use of the interface is enabled.

- When ES0 = "0", the following is performed.
- PIN = "1", BB = "0" and AL = "0" are set (which are bits of the I²C status register at address 002D16).
- Writing data to the I²C data shift register (address 002B16) is disabled.

•Bit 4: Data format selection bit (ALS)

This bit decides whether or not to recognize slave addresses. When this bit is set to "0", the addressing format is selected, so that address data is recognized. When a match is found between a slave address and address data as a result of comparison or when a general call (refer to " I^2C Status Register", bit 1) is received, transfer processing can be performed. When this bit is set to "1", the free data format is selected, so that slave addresses are not recognized.

•Bit 5: Addressing format selection bit (10BIT SAD)

This bit selects a slave address specification format. When this bit is set to "0", the 7-bit addressing format is selected. In this case, only the high-order 7 bits (slave address) of the I^2C address register (address 002C16) are compared with address data. When this bit is set to "1", the 10-bit addressing format is selected, and all the bits of the I^2C address register are compared with address data.

•Bit 6: SDA/SCL pin selection bit (TSEL)

This bit selects the input/output pins of SCL and SDA of the multi-master I 2 C-BUS interface.

•Bit 7: I²C-BUS interface pin input level selection bit (TISS)

This bit selects the input level of the SCL and SDA pins of the multi-master $\mathsf{I}^2\mathsf{C}\text{-}\mathsf{BUS}$ interface.

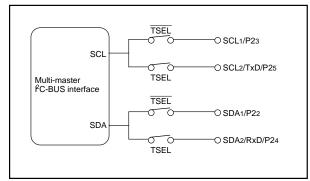


Fig. 30 SDA/SCL pin selection bit

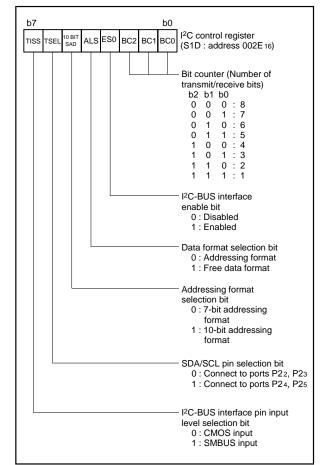


Fig. 31 Structure of I²C control register

[I²C Status Register (S1)] 002D16

The I^2C status register (address 002D16) controls the I^2C -BUS interface status. The low-order 4 bits are read-only bits and the high-order 4 bits can be read out and written to.

Set "00002" to the low-order 4 bits, because these bits become the reserved bits at writing.

•Bit 0: Last receive bit (LRB)

This bit stores the last bit value of received data and can also be used for ACK receive confirmation. If ACK is returned when an ACK clock occurs, the LRB bit is set to "0". If ACK is not returned, this bit is set to "1". Except in the ACK mode, the last bit value of received data is input. The state of this bit is changed from "1" to "0" by executing a write instruction to the I²C data shift register (address 002B16).

•Bit 1: General call detecting flag (AD0)

When the ALS bit is "0", this bit is set to "1" when a general call* whose address data is all "0" is received in the slave mode. By a general call of the master device, every slave device receives control data after the general call. The AD0 bit is set to "0" by detecting the STOP condition or START condition, or reset.

*General call: The master transmits the general call address "0016" to all slaves.

•Bit 2: Slave address comparison flag (AAS)

This flag indicates a comparison result of address data when the ALS bit is "0".

- (1) In the slave receive mode, when the 7-bit addressing format is selected, this bit is set to "1" in one of the following conditions:
 - The address data immediately after occurrence of a START condition agrees with the slave address stored in the high-order 7 bits of the l^2C address register (address 002C16).
 - A general call is received.
- (2) In the slave receive mode, when the 10-bit addressing format is selected, this bit is set to "1" with the following condition:
 - When the address data is compared with the I²C address register (8 bits consisting of slave address and RWB bit), the first bytes agree.
- (3) This bit is set to "0" by executing a write instruction to the I²C data shift register (address 002B16) when ES0 is set to "1" or reset.

•Bit 3: Arbitration lost* detecting flag (AL)

In the master transmission mode, when the SDA is made "L" by any other device, arbitration is judged to have been lost, so that this bit is set to "1". At the same time, the TRX bit is set to "0", so that immediately after transmission of the byte whose arbitration was lost is completed, the MST bit is set to "0". The arbitration lost can be detected only in the master transmission mode. When arbitration is lost during slave address transmission, the TRX bit is set to "0" and the reception mode is set. Consequently, it becomes possible to detect the agreement of its own slave address and address data transmitted by another master device.

*Arbitration lost :The status in which communication as a master is disabled.

•Bit 4: SCL pin low hold bit (PIN)

This bit generates an interrupt request signal. Each time 1-byte data is transmitted, the PIN bit changes from "1" to "0". At the same time, an interrupt request signal occurs to the CPU. The PIN bit is set to "0" in synchronization with a falling of the last clock (including the ACK clock) of an internal clock and an interrupt request signal occurs in synchronization with a falling of the PIN bit. When the PIN bit is "0", the SCL is kept in the "0" state and clock generation is disabled. Figure 33 shows an interrupt request signal generating timing chart.

The PIN bit is set to "1" in one of the following conditions:

- Executing a write instruction to the I²C data shift register (address 002B16). (This is the only condition which the prohibition of the internal clock is released and data can be communicated except for the start condition detection.)
- When the ES0 bit is "0"
- At reset
- When writing "1" to the PIN bit by software
- The conditions in which the PIN bit is set to "0" are shown below:
- Immediately after completion of 1-byte data transmission (including when arbitration lost is detected)
- · Immediately after completion of 1-byte data reception
- In the slave reception mode, with ALS = "0" and immediately after completion of slave address agreement or general call address reception
- In the slave reception mode, with ALS = "1" and immediately after completion of address data reception

•Bit 5: Bus busy flag (BB)

This bit indicates the status of use of the bus system. When this bit is set to "0", this bus system is not busy and a START condition can be generated. The BB flag is set/reset by the SCL, SDA pins input signal regardless of master/slave. This flag is set to "1" by detecting the start condition, and is set to "0" by detecting the stop condition. The condition of these detecting is set by the start/stop condition setting bits (SSC4–SSC0) of the I²C start/stop condition control register (address 003016). When the ES0 bit of the I²C control register (address 002E16) is "0" or reset, the BB flag is set to "0".

For the writing function to the BB flag, refer to the sections "START Condition Generating Method" and "STOP Condition Generating Method" described later.

•Bit 6: Communication mode specification bit (transfer direction specification bit: TRX)

This bit decides a direction of transfer for data communication. When this bit is "0", the reception mode is selected and the data of a transmitting device is received. When the bit is "1", the transmission mode is selected and address data and control data are output onto the SDA in synchronization with the clock generated on the SCL.

This bit is set/reset by software and hardware. About set/reset by hardware is described below. This bit is set to "1" by hardware when all the following conditions are satisfied:

- When ALS is "0"
- In the slave reception mode or the slave transmission mode
- When the R/W bit reception is "1"
- This bit is set to "0" in one of the following conditions:
- When arbitration lost is detected.
- When a STOP condition is detected.
- When writing "1" to this bit by software is invalid by the START condition duplication preventing function (Note).
- With MST = "0" and when a START condition is detected.
- With MST = "0" and when ACK non-return is detected.
- At reset

•Bit 7: Communication mode specification bit (master/slave specification bit: MST)

This bit is used for master/slave specification for data communication. When this bit is "0", the slave is specified, so that a START condition and a STOP condition generated by the master are received, and data communication is performed in synchronization with the clock generated by the master. When this bit is "1", the master is specified and a START condition and a STOP condition are generated. Additionally, the clocks required for data communication are generated on the SCL.

This bit is set to "0" in one of the following conditions.

- Immediately after completion of 1-byte data transfer when arbitration lost is detected
- When a STOP condition is detected.
- Writing "1" to this bit by software is invalid by the START condition duplication preventing function (Note).
- · At reset
- Note: START condition duplication preventing function
 - The MST, TRX, and BB bits is set to "1" at the same time after confirming that the BB flag is "0" in the procedure of a START condition occurrence. However, when a START condition by another master device occurs and the BB flag is set to "1" immediately after the contents of the BB flag is confirmed, the START condition duplication preventing function makes the writing to the MST and TRX bits invalid. The duplication preventing function becomes valid from the rising of the BB flag to reception completion of slave address.

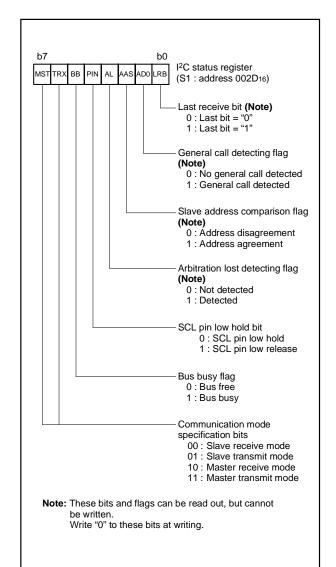
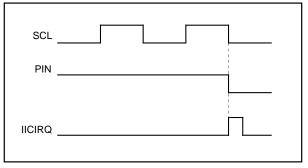


Fig. 32 Structure of I²C status register





START Condition Generating Method

When writing "1" to the MST, TRX, and BB bits of the l^2C status register (address 002D16) at the same time after writing the slave address to the l^2C data shift register (address 002B16) with the condition in which the ES0 bit of the l^2C control register (address 002E16) and the BB flag are "0", a START condition occurs. After that, the bit counter becomes "0002" and an SCL for 1 byte is output. The START condition generating timing is different in the standard clock mode and the high-speed clock mode. Refer to Figure 34, the START condition generating timing diagram, and Table 11, the START condition generating timing table.

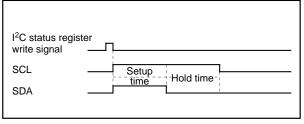


Fig. 34 START condition generating timing diagram

Table 11 START condition generating timing table

Item	Standard clock mode	High-speed clock mode
Setup time	5.0 µs (20 cycles)	2.5 µs (10 cycles)
Hold time	5.0 μs (20 cycles)	2.5 μs (10 cycles)

Note: Absolute time at ϕ = 4 MHz. The value in parentheses denotes the number of ϕ cycles.

STOP Condition Generating Method

When the ES0 bit of the l^2C control register (address 002E16) is "1", write "1" to the MST and TRX bits, and write "0" to the BB bit of the l^2C status register (address 002D16) simultaneously. Then a STOP condition occurs. The STOP condition generating timing is different in the standard clock mode and the high-speed clock mode. Refer to Figure 35, the STOP condition generating timing diagram, and Table 12, the STOP condition generating timing table.

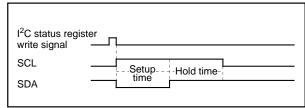


Fig. 35 STOP condition generating timing diagram

Table 12 STOP condition generating timing table

Item	Standard clock mode	High-speed clock mode
Setup time	5.0 µs (20 cycles)	3.0 µs (12 cycles)
Hold time	4.5 μs (18 cycles)	2.5 µs (10 cycles)

Note: Absolute time at $\phi = 4$ MHz. The value in parentheses denotes the number of ϕ cycles.

START/STOP Condition Detecting Operation

The START/STOP condition detection operations are shown in Figures 36, 37, and Table 13. The START/STOP condition is set by the START/STOP condition set bit.

The START/STOP condition can be detected only when the input signal of the SCL and SDA pins satisfy three conditions: SCL release time, setup time, and hold time (see Table 13).

The BB flag is set to "1" by detecting the START condition and is reset to "0" by detecting the STOP condition.

The BB flag set/reset timing is different in the standard clock mode and the high-speed clock mode. Refer to Table 13, the BB flag set/ reset time.

Note: When a STOP condition is detected in the slave mode (MST = 0), an interrupt request signal "IICIRQ" occurs to the CPU.

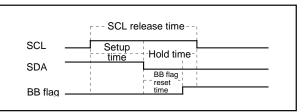


Fig. 36 START condition detecting timing diagram

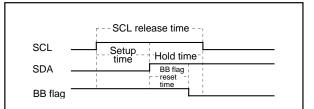


Fig. 37 STOP condition detecting timing diagram

	Standard clock mode	High-speed clock mode
SCL release time	SSC value + 1 cycle (6.25 µs)	4 cycles (1.0 μs)
Setup time	<u>SSC value + 1</u> cycle < 4.0 μs (3.125 μs) 2	2 cycles (1.0 µs)
Hold time	$\frac{\text{SSC value + 1}}{2} \text{ cycle < 4.0 } \mu \text{s} (3.125 \ \mu \text{s})$	2 cycles (0.5 µs)
BB flag set/ reset time	$\frac{\text{SSC value} - 1}{2} + 2 \text{ cycles } (3.375 \mu\text{s})$	3.5 cycles (0.875 μs)

Table 13 START condition/STOP condition detecting conditions

Note: Unit : Cycle number of system clock o

SSC value is the decimal notation value of the START/STOP condition set bits SSC4 to SSC0. Do not set "0" or an odd number to SSC value. The value in parentheses is an example when the $I^{2}C$ START/ STOP condition control register is set to "1816" at $\phi = 4$ MHz.



[I²C START/STOP Condition Control Register (S2D)] 003016

The I²C START/STOP condition control register (address 003016) controls START/STOP condition detection.

•Bits 0 to 4: START/STOP condition set bit (SSC4-SSC0)

SCL release time, setup time, and hold time change the detection condition by value of the main clock divide ratio selection bit and the oscillation frequency f(XIN) because these time are measured by the internal system clock. Accordingly, set the proper value to the START/STOP condition set bits (SSC4 to SSC0) in considered of the system clock frequency. Refer to Table 13.

Do not set "000002" or an odd number to the START/STOP condition set bit (SSC4 to SSC0).

Refer to Table 14, the recommended set value to START/STOP condition set bits (SSC4–SSC0) for each oscillation frequency.

•Bit 5: SCL/SDA interrupt pin polarity selection bit (SIP)

An interrupt can occur when detecting the falling or rising edge of the SCL or SDA pin. This bit selects the polarity of the SCL or SDA pin interrupt pin.

•Bit 6: SCL/SDA interrupt pin selection bit (SIS)

This bit selects the pin of which interrupt becomes valid between the SCL pin and the SDA pin.

Note: When changing the setting of the SCL/SDA interrupt pin polarity selection bit, the SCL/SDA interrupt pin selection bit, or the I²C-BUS interface enable bit ES0, the SCL/SDA interrupt request bit may be set. When selecting the SCL/SDA interrupt source, disable the interrupt before the SCL/SDA interrupt selection bit, the SCL/ SDA interrupt pin selection bit, or the I²C-BUS interface enable bit ES0 is set. Reset the request bit to "0" after setting these bits, and enable the interrupt.

Address Data Communication

There are two address data communication formats, namely, 7-bit addressing format and 10-bit addressing format. The respective address communication formats are described below.

(1) 7-bit addressing format

To adapt the 7-bit addressing format, set the 10BIT SAD bit of the I²C control register (address 002E16) to "0". The first 7-bit address data transmitted from the master is compared with the high-order 7-bit slave address stored in the I²C address register (address 002C16). At the time of this comparison, address comparison of the RWB bit of the I²C address register (address 002C16) is not performed. For the data transmission format when the 7-bit addressing format is selected, refer to Figure 39, (1) and (2).

(2) 10-bit addressing format

To adapt the 10-bit addressing format, set the 10BIT SAD bit of the I²C control register (address 002E16) to "1". An address comparison is performed between the first-byte address data transmitted from the master and the 8-bit slave address stored in the I²C address register (address 002C16). At the time of this comparison, an address comparison between the RWB bit of the I²C address register (address 002C16) and the R/W bit which is the last bit of the address data transmitted from the master is made. In the 10-bit addressing mode, the RWB bit which is the last bit of the address data not only specifies the direction of communication for control data, but also is processed as an address data bit.

When the first-byte address data agree with the slave address, the AAS bit of the l^2C status register (address 002D16) is set to "1". After the second-byte address data is stored into the l^2C data shift register (address 002B16), perform an address comparison between the second-byte data and the slave address by software. When the address data of the 2 bytes agree with the slave address, set the RWB bit of the l^2C address register (address 002C16) to "1" by software. This processing can make the 7-bit slave address and R/\overline{W} data agree, which are received after a RESTART condition is detected, with the value of the l^2C address register (address 002C16). For the data transmission format when the 10-bit addressing format is selected, refer to Figure 39, (3) and (4).

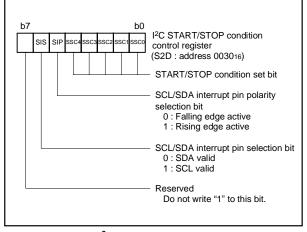


Fig. 38 Structure of I²C START/STOP condition control register

Oscillation frequency f(XIN) (MHz)	Main clock divide ratio	System clock ¢ (MHz)	START/STOP condition control register	SCL release time (µs)	Setup time (µs)	Hold time (µs)
	0	4	XXX11010	6.75 μs (27 cycles)	3.375 μs (13.5 cycles)	3.375 µs (13.5 cycles)
8	2	4	XXX11000	6.25 µs (25 cycles)	3.125 µs (12.5 cycles)	3.125 µs (12.5 cycles)
8	8	1	XXX00100	5.0 µs (5 cycles)	2.5 µs (2.5 cycles)	2.5 µs (2.5 cycles)
4	0	2	XXX01100	6.5 μs (13 cycles)	3.25 µs (6.5 cycles)	3.25 µs (6.5 cycles)
4	2	2	XXX01010	5.5 µs (11 cycles)	2.75 μs (5.5 cycles)	2.75 μs (5.5 cycles)
2	2	1	XXX00100	5.0 µs (5 cycles)	2.5 µs (2.5 cycles)	2.5 µs (2.5 cycles)

Note: Do not set an odd number to the START/STOP condition set bit (SSC4 to SSC0).

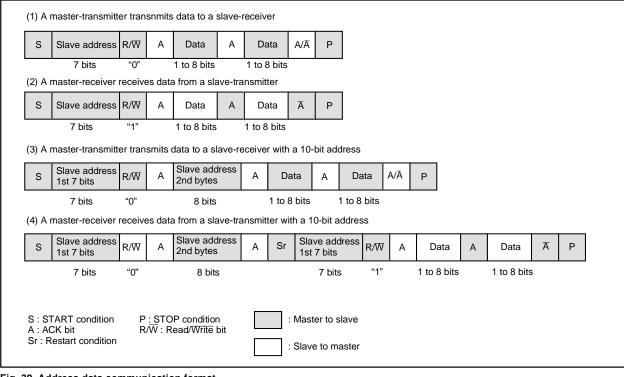


Fig. 39 Address data communication format

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Example of Master Transmission

An example of master transmission in the standard clock mode, at the SCL frequency of 100 kHz and in the ACK return mode is shown below.

- Set a slave address in the high-order 7 bits of the I²C address register (address 002C16) and "0" into the RWB bit.
- (2) Set the ACK return mode and SCL = 100 kHz by setting "8516" in the I²C clock control register (address 002F16).
- (3) Set "0016" in the I²C status register (address 002D16) so that transmission/reception mode can become initializing condition.
- (4) Set a communication enable status by setting "0816" in the I²C control register (address 002E16).
- (5) Confirm the bus free condition by the BB flag of the I²C status register (address 002D16).
- (6) Set the address data of the destination of transmission in the high-order 7 bits of the I²C data shift register (address 002B16) and set "0" in the least significant bit.
- (7) Set "F016" in the I²C status register (address 002D16) to generate a START condition. At this time, an SCL for 1 byte and an ACK clock automatically occur.
- (8) Set transmit data in the I²C data shift register (address 002B16). At this time, an SCL and an ACK clock automatically occur.
- (9) When transmitting control data of more than 1 byte, repeat step (8).
- (10) Set "D016" in the I²C status register (address 002D16) to generate a STOP condition if ACK is not returned from slave reception side or transmission ends.

Example of Slave Reception

An example of slave reception in the high-speed clock mode, at the SCL frequency of 400 kHz, in the ACK non-return mode and using the addressing format is shown below.

- Set a slave address in the high-order 7 bits of the I²C address register (address 002C16) and "0" in the RWB bit.
- (2) Set the no ACK clock mode and SCL = 400 kHz by setting "2516" in the I²C clock control register (address 002F16).
- (3) Set "0016" in the I²C status register (address 002D16) so that transmission/reception mode can become initializing condition.
- (4) Set a communication enable status by setting "0816" in the I²C control register (address 002E16).
- (5) When a START condition is received, an address comparison is performed.
- (6) When all transmitted addresses are "0" (general call):
 AD0 of the I²C status register (address 002D16) is set to "1" and an interrupt request signal occurs.
 - When the transmitted addresses agree with the address set in (1):
 - ASS of the I²C status register (address 002D16) is set to "1" and an interrupt request signal occurs.
 - In the cases other than the above AD0 and AAS of the I²C status register (address 002D16) are set to "0" and no interrupt request signal occurs.
- (7) Set dummy data in the I²C data shift register (address 002B16).

- (8) When receiving control data of more than 1 byte, repeat step (7).
- (9) When a STOP condition is detected, the communication ends.

Precautions when using multi-master I²C-BUS interface

(1) Read-modify-write instruction

The precautions when the read-modify-write instruction such as SEB, CLB etc. is executed for each register of the multi-master I^2 C-BUS interface are described below.

- I²C data shift register (S0: address 002B16)
 When executing the read-modify-write instruction for this register during transfer, data may become a value not intended.
- I²C address register (S0D: address 002C16)
 When the read-modify-write instruction is executed for this register at detecting the STOP condition, data may become a value not intended. It is because H/W changes the read/write bit (RWB) at the above timing.
- I²C status register (S1: address 002D16)
 Do not execute the read-modify-write instruction for this register because all bits of this register are changed by H/W.
- I²C control register (S1D: address 002E16)
 When the read-modify-write instruction is executed for this register at detecting the START condition or at completing the byte transfer, data may become a value not intended. Because H/W changes the bit counter (BC0-BC2) at the above timing.
- I²C clock control register (S2: address 002F16) The read-modify-write instruction can be executed for this register.
- I²C START/STOP condition control register (S2D: address 003016)

The read-modify-write instruction can be executed for this register.

(2) START condition generating procedure using multi-master

1. Procedure example (The necessary conditions of the generating procedure are described in Items 2 to 5 below.

LDA —	(Taking out of slave address value)
SEI	(Interrupt disabled)
BBS 5, S1, BUSBUSY	(BB flag confirming and branch process)
BUSFREE:	
STA SO	(Writing of slave address value)
LDM #\$F0, S1	(Trigger of START condition generating)
CLI	(Interrupt enabled)
BUSBUSY:	
CLI	(Interrupt enabled)
•	

- 2. Use "Branch on Bit Set" of "BBS 5, \$002D, --" for the BB flag confirming and branch process.
- Use "STA \$2B, STX \$2B" or "STY \$2B" of the zero page addressing instruction for writing the slave address value to the I²C data shift register.
- 4. Execute the branch instruction of Item 2 and the store instruction of Item 3 continuously, as shown in the procedure example above.

- 5. Disable interrupts during the following three process steps:BB flag confirming
 - Writing of slave address value
 - Trigger of START condition generating

When the condition of the BB flag is bus busy, enable interrupts immediately.

(3) RESTART condition generating procedure

1. Procedure example (The necessary conditions for the procedure are described in items 2 to 4 below.)

Execute the following	procedure when	the PIN bit is "()".

LDM #\$00, S1	(Select slave receive mode)
LDA —	(Take out of slave address value)
SEI	(Disable interrupt)
STA S0	(Write slave address value)
LDM #\$F0, S1	(Trigger RESTART condition generation)
CLI	(Enable interrupt)
:	

2. Select the slave receive mode when the PIN bit is "0". Do not write "1" to the PIN bit. Neither "0" nor "1" is specified as input to the BB bit.

The TRX bit becomes "0" and the SDA pin is released.

- 3. The SCL pin is released by writing the slave address value to the $\rm l^2C$ data shift register.
- 4. Disable interrupts during the following two process steps:
 - Write slave address value
- Trigger RESTART condition generation

(4) Writing to I²C status register

Do not execute an instruction to set the PIN bit to "1" from "0" and an instruction to set the MST and TRX bits to "0" from "1" simultaneously. Because it may enter the state that the SCL pin is released and the SDA pin is released after about one machine cycle. Do not execute an instruction to set the MST and TRX bits to "0" from "1" simultaneously when the PIN bit is "1". Because it may become the same as above.

(5) Process of after STOP condition generating

Do not write data in the l^2C data shift register S0 and the l^2C status register S1 until the bus busy flag BB becomes "0" after generating the STOP condition in the master mode. Because the STOP condition waveform might not be normally generated. Reading to the above registers do not have the problem.

PULSE WIDTH MODULATION (PWM)

The 3851 group (built-in 24 KB or more ROM) has a PWM function with an 8-bit resolution, based on a signal that is the clock input XIN or that clock input divided by 2.

Data Setting

The PWM output pin also functions as port P44. Set the PWM period by the PWM prescaler, and set the "H" term of output pulse by the PWM register.

If the value in the PWM prescaler is n and the value in the PWM register is m (where n = 0 to 255 and m = 0 to 255) :

PWM period = $255 \times (n+1) / f(XIN)$

(when f(XIN) = 8 MHz,count source selection bit = "0")

Output pulse "H" term = PWM period X m / 255

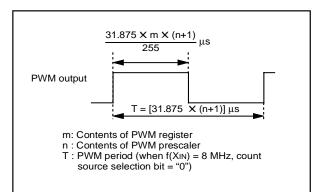
= 0.125 X (n+1) X m μ s

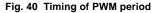
(when f(XIN) = 8 MHz,count source selection bit = "0")

PWM Operation

When bit 0 (PWM enable bit) of the PWM control register is set to "1", operation starts by initializing the PWM output circuit, and pulses are output starting at an "H".

If the PWM register or PWM prescaler is updated during PWM output, the pulses will change in the cycle after the one in which the change was made.





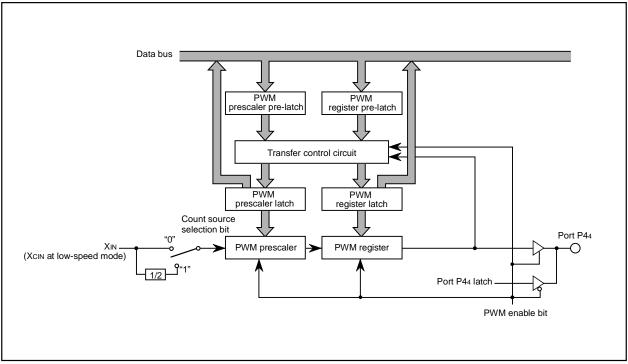


Fig. 41 Block diagram of PWM function

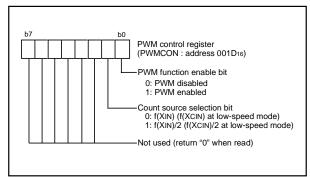


Fig. 42 Structure of PWM control register

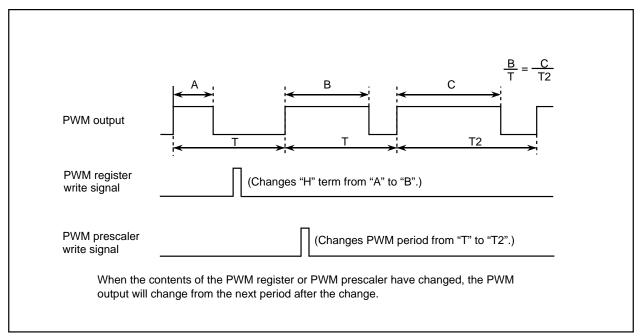
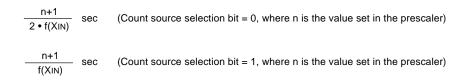


Fig. 43 PWM output timing when PWM register or PWM prescaler is changed

Note

The PWM starts after the PWM function enable bit is set to enable and "L" level is output from the PWM pin. The length of this "L" level output is as follows:



A-D CONVERTER [A-D Conversion Registers (ADL, ADH)] 003516, 003616

The A-D conversion registers are read-only registers that store the result of an A-D conversion. Do not read these registers during an A-D conversion.

[A-D Control Register (ADCON)] 003416

The AD control register controls the A-D conversion process. Bits 0 to 2 select a specific analog input pin. Bit 4 indicates the completion of an A-D conversion. The value of this bit remains at "0" during an A-D conversion and changes to "1" when an A-D conversion ends. Writing "0" to this bit starts the A-D conversion.

Comparison Voltage Generator

The comparison voltage generator divides the voltage between AVss and VREF into 1024 and outputs the divided voltages.

Channel Selector

The channel selector selects one of ports P30/AN0 to P34/AN4 and inputs the voltage to the comparator.

Comparator and Control Circuit

The comparator and control circuit compare an analog input voltage with the comparison voltage, and the result is stored in the A-D conversion registers. When an A-D conversion is completed, the control circuit sets the A-D conversion completion bit and the A-D interrupt request bit to "1".

Note that because the comparator consists of a capacitor coupling, set f(XIN) to 500 kHz or more during an A-D conversion.

When the A-D converter is operated at low-speed mode, f(XIN) and f(XCIN) do not have the lower limit of frequency, because of the A-D converter has a built-in self-oscillation circuit.

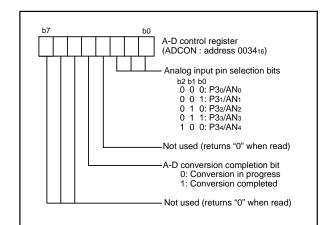


Fig. 44 Structure of A-D control register

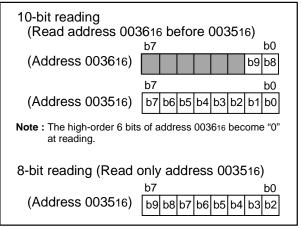


Fig. 45 Structure of A-D conversion registers

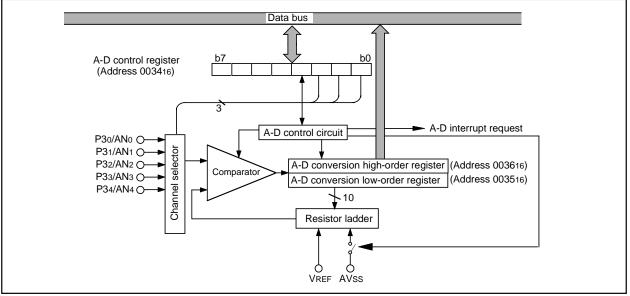


Fig. 46 Block diagram of A-D converter

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WATCHDOG TIMER

The watchdog timer gives a mean of returning to the reset status when a program cannot run on a normal loop (for example, because of a software run-away). The watchdog timer consists of an 8-bit watchdog timer L and an 8-bit watchdog timer H.

Standard Operation of Watchdog Timer

When any data is not written into the watchdog timer control register (address 003916) after reset, the watchdog timer is in the stop state. The watchdog timer starts to count down by writing an optional value into the watchdog timer control register (address 003916) and an internal reset occurs at an underflow of the watchdog timer H.

Accordingly, programming is usually performed so that writing to the watchdog timer control register (address 003916) may be started before an underflow. When the watchdog timer control register (address 003916) is read, the values of the high-order 6 bits of the watchdog timer H, STP instruction disable bit, and watchdog timer H count source selection bit are read.

Initial value of watchdog timer

At reset or writing to the watchdog timer control register (address 003916), each watchdog timer H and L are set to "FF16".

•Watchdog timer H count source selection bit operation

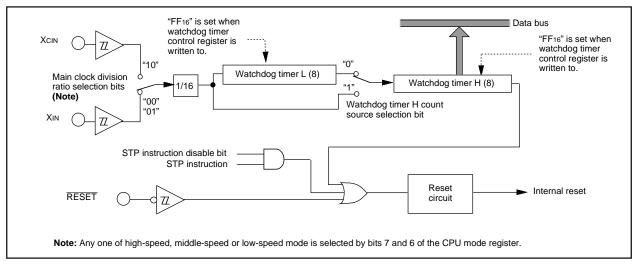
Bit 7 of the watchdog timer control register (address 003916) permits selecting a watchdog timer H count source. When this bit is set to "0", the count source becomes the underflow signal of watchdog timer L. The detection time is set to 131.072 ms at f(XIN) = 8 MHz frequency and 32.768 s at f(XCIN) = 32 kHz frequency. When this bit is set to "1", the count source becomes the signal divided by 16 for f(XIN) (or f(XCIN)). The detection time in this case is set to 512 μ s at f(XIN) = 8 MHz frequency and 128 ms at f(XCIN) = 32 kHz frequency. This bit is cleared to "0" after reset.

Operation of STP instruction disable bit

Bit 6 of the watchdog timer control register (address 003916) permits disabling the STP instruction when the watchdog timer is in operation.

When this bit is "0", the STP instruction is enabled.

When this bit is "1", the STP instruction is disabled, once the STP instruction is executed, an internal reset occurs. When this bit is set to "1", it cannot be rewritten to "0" by program. This bit is cleared to "0" after reset.





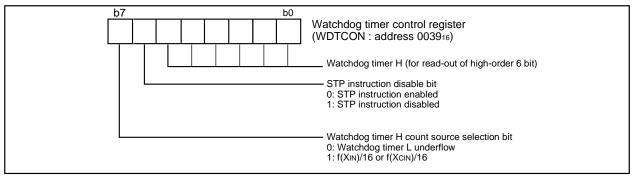


Fig. 48 Structure of Watchdog timer control register

RESET CIRCUIT

To reset the microcomputer, RESET pin must be held at an "L" level for 20 cycles or more of XIN. Then the RESET pin is returned to an "H" level (the power source voltage must be between 2.7 V and 5.5 V, and the oscillation must be stable), reset is released. After the reset is completed, the program starts from the address contained in address FFFD16 (high-order byte) and address FFFC16 (low-order byte). Make sure that the reset input voltage is less than 0.54 V for Vcc of 2.7 V.

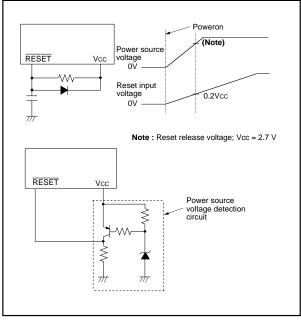


Fig. 49 Reset circuit example

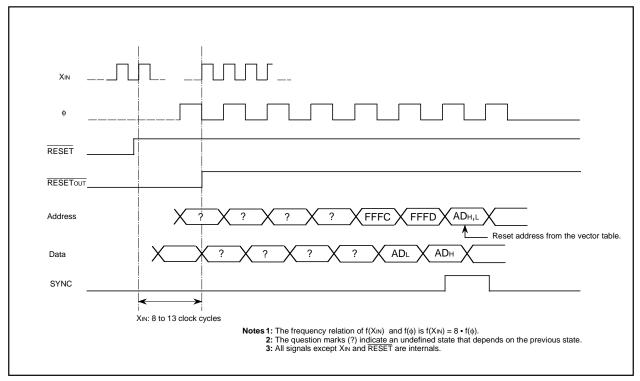


Fig. 50 Reset sequence

		Address Register contents		Address Register contents
(1)	Port P0 (P0)	000016 0016	(36) A-D control register (ADCON)	003416 0 0 0 1 0 0 0
(2)	Port P0 direction register (P0D)	000116 0016	(37) A-D conversion low-order register (ADL)	003516 X X X X X X X X
(3)	Port P1 (P1)	000216 0016	(38) A-D conversion high-order register (ADH	H) 003616 0 0 0 0 0 X X
(4)	Port P1 direction register (P1D)	000316 0016	(39) MISRG	003816 0016
(5)	Port P2 (P2)	000416 0016	(40) Watchdog timer control register (WDTCON)	003916 0 0 1 1 1 1 1 1
(6)	Port P2 direction register (P2D)	000516 0016	(41) Interrupt edge selection register (INTEDGE)	003A16 0016
(7)	Port P3 (P3)	000616 0016	(42) CPU mode register (CPUM)	003B16 0 1 0 0 1 0 0 0
(8)	Port P3 direction register (P3D)	000716 0016	(43) Interrupt request register 1 (IREQ1)	003C16 0016
(9)	Port P4 (P4)	000816 0016	(44) Interrupt request register 2 (IREQ2)	003D16 0016
(10)	Port P4 direction register (P4D)	000916 0016	(45) Interrupt control register 1 (ICON1)	003E16 0016
(11)	Serial I/O2 control register 1 (SIO2CON1)	001516 0016	(46) Interrupt control register 2 (ICON2)	003F16 0016
(12)	Serial I/O2 control register 2 (SIO2CON2)	001616 0 0 0 0 0 1 1 1	(47) Processor status register	(PS) X X X X 1 X X
(13)	Serial I/O2 register (SIO2)	0017 ₁₆ X X X X X X X X	(48) Program counter	(PCH) FFFD16 contents
(14)	Transmit/Receive buffer register (TB/RB)	001816 X X X X X X X X X		(PCL) FFFC16 contents
(15)	Serial I/O1 status register (SIOSTS)	001916 1 0 0 0 0 0 0	Note : X : Not fixed	
(16)	Serial I/O1 control register (SIOCON)	001A16 0016	Since the initial values for other than a RAM contents are indefinite at reset, t	•
(17)	UART control register (UARTCON)	001B16 1 1 1 0 0 0 0 0		
(18)	Baud rate generator (BRG)	001C16 X X X X X X X X		
(19)	PWM control register (PWMCON)	001D16 0016		
(20)	PWM prescaler (PREPWM)	001E16 X X X X X X X X X		
(21)	PWM register (PWM)	001F16 X X X X X X X X		
(22)	Prescaler 12 (PRE12)	002016 FF16		
(23)	Timer 1 (T1)	002116 0116		
(24)	Timer 2 (T2)	002216 0016		
(25)	Timer XY mode register (TM)	002316 0016		
(26)	Prescaler X (PREX)	002416 FF16		
(27)	Timer X (TX)	002516 FF16		
(28)	Prescaler Y (PREY)	002616 FF16		
(29)	Timer Y (TY)	002716 FF16		
(30)	Timer count source selection register (TCSS)	002816 0016		
(31)	I ² C address regiter (S0D)	002C16 0016		
(32)	I ² C status register (S1)	002D16 0 0 1 0 0 X		
(33)	I ² C control register (S1D)	002E16 0016		
(34)	I ² C clock control register (S2)	002F16 0016		
(35)	I ² C start/stop condition control register (S2D	003016 0 0 0 X X X X X X		

Fig. 51 Internal status at reset

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CLOCK GENERATING CIRCUIT

The 3851 group (built-in 24 KB or more ROM) has two built-in oscillation circuits: main clock XIN-XOUT oscillation circuit and sub clock XCIN-XCOUT oscillation circuit. An oscillation circuit can be formed by connecting a resonator between XIN and XOUT (XCIN and XCOUT). Use the circuit constants in accordance with the resonator manufacturer's recommended values. No external resistor is needed between XIN and XOUT since a feed-back resistor exists on-chip. However, an external feed-back resistor is needed between XCIN and XCOUT.

Immediately after power on, only the XIN oscillation circuit starts oscillating, and XCIN and XCOUT pins function as I/O ports.

Frequency Control (1) Middle-speed mode

The internal clock ϕ is the frequency of XIN divided by 8. After reset is released, this mode is selected.

(2) High-speed mode

The internal clock ϕ is half the frequency of XIN.

(3) Low-speed mode

The internal clock ϕ is half the frequency of XCIN.

Note

If you switch the mode between middle/high-speed and lowspeed, stabilize both XIN and XCIN oscillations. The sufficient time is required for the sub-clock to stabilize, especially immediately after power on and at returning from the stop mode. When switching the mode between middle/high-speed and low-speed, set the frequency on condition that $f(XIN) > 3 \cdot f(XCIN)$.

(4) Low power dissipation mode

The low power consumption operation can be realized by stopping the main clock XIN in low-speed mode. To stop the main clock, set bit 5 of the CPU mode register to "1". When the main clock XIN is restarted (by setting the main clock stop bit to "0"), set sufficient time for oscillation to stabilize.

The sub-clock XCIN-XCOUT oscillation circuit can not directly input clocks that are generated externally. Accordingly, make sure to cause an external resonator to oscillate.

Oscillation Control (1) Stop mode

If the STP instruction is executed, the internal clock ϕ stops at an "H" level, and XIN and XCIN oscillation stops. When the oscillation stabilizing time set after STP instruction released bit is "0", the prescaler 12 is set to "FF16" and timer 1 is set to "0116". When the oscillation stabilizing time set after STP instruction released bit is "1", set the sufficient time for oscillation of used oscillator to stabilize since nothing is set to the prescaler 12 and timer 1.

Either XIN or XCIN divided by 16 is input to the prescaler 12 as count source. Oscillator restarts when an external interrupt is received, but the internal clock ϕ is not supplied to the CPU (remains at "H") until timer 1 underflows. The internal clock ϕ is supplied for the first time, when timer 1 underflows. This ensures time for the clock oscillation using the ceramic resonators to be stabilized.

When the oscillator is restarted by reset, apply "L" level to the $\overline{\mathsf{RESET}}$ pin until the oscillation is stable since a wait time will not be generated.

(2) Wait mode

If the WIT instruction is executed, the internal clock ϕ stops at an "H" level, but the oscillator does not stop. The internal clock ϕ restarts at reset or when an interrupt is received. Since the oscillator does not stop, normal operation can be started immediately after the clock is restarted.

To ensure that the interrupts will be received to release the STP or WIT state, their interrupt enable bits must be set to "1" before executing of the STP or WIT instruction.

When releasing the STP state, the prescaler 12 and timer 1 will start counting the clock XIN divided by 16. Accordingly, set the timer 1 interrupt enable bit to "0" before executing the STP instruction.

Note

When using the oscillation stabilizing time set after STP instruction released bit set to "1", evaluate time to stabilize oscillation of the used oscillator and set the value to the timer 1 and prescaler 12.

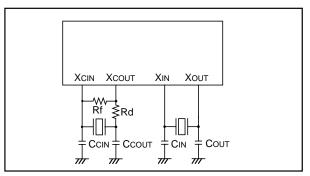


Fig. 52 Ceramic resonator circuit

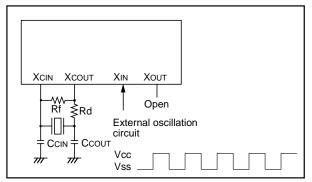


Fig. 53 External clock input circuit



Notes on middle-speed mode automatic switch set bit

When the middle-speed mode automatic switch set bit is set to "1" while operating in the low-speed mode, by detecting the rising/falling edge of the SCL or SDA pin, XIN oscillation automatically starts and the mode is automatically switched to the middle-speed mode. The timing which changes from the low-speed mode to the middle-speed mode can be set as 4.5 to 5.5 cycle, or 6.5 to 7.5 cycle in the low-speed mode by the middle-speed mode automatic switch waiting time set bit. Select according to the oscillation start characteristic of the XIN oscillator to be used.

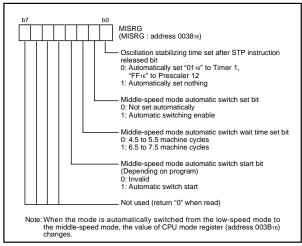


Fig. 54 Structure of MISRG

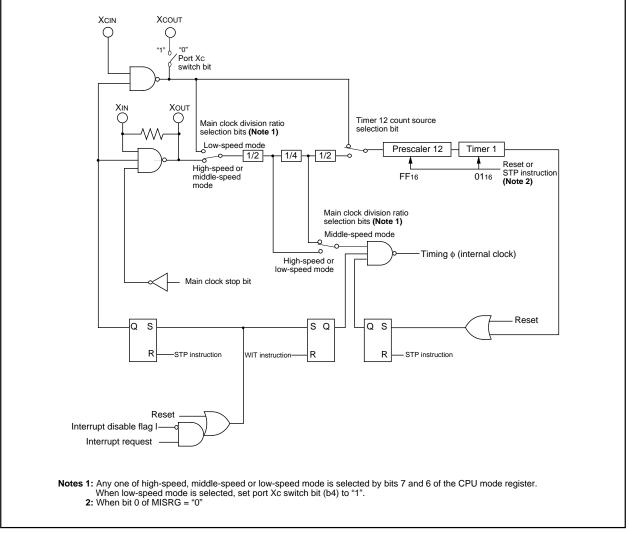
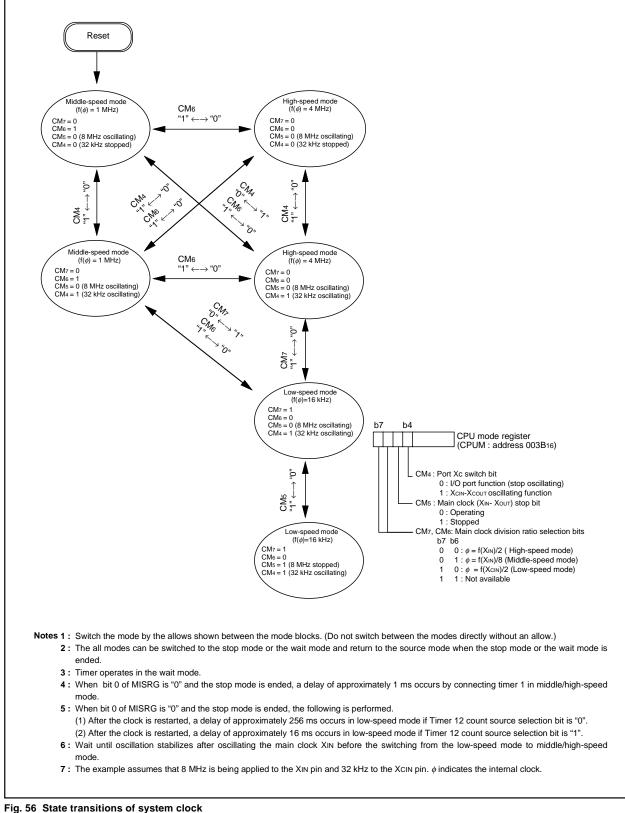


Fig. 55 System clock generating circuit block diagram (Single-chip mode)



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FLASH MEMORY MODE

The M38517F8 (flash memory version) has an internal new DINOR (DIvided bit line NOR) flash memory that can be rewritten with a single power source when Vcc is 5 V, and 2 power sources when VPP is 5 V and Vcc is 3.0-5.5 V in the CPU rewrite and standard serial I/O modes.

For this flash memory, three flash memory modes are available in which to read, program, and erase: the parallel I/O and standard serial I/O modes in which the flash memory can be manipulated using a programmer and the CPU rewrite mode in which the flash memory can be manipulated by the Central Processing Unit (CPU).

Summary

Table 15 lists the summary of the M38517F8 (flash memory version).

The flash memory of the M38517F8 is divided into User ROM area and Boot ROM area as shown in Figure 57.

In addition to the ordinary User ROM area to store the MCU operation control program, the flash memory has a Boot ROM area that is used to store a program to control rewriting in CPU rewrite and standard serial I/O modes. This Boot ROM area has had a standard serial I/O mode control program stored in it when shipped from the factory. However, the user can write a rewrite control program in this area that suits the user's application system. This Boot ROM area can be rewritten in only parallel I/O mode.

Table 15 Summary of M38517F8 (flash memory version)

	Item	Specifications		
Power source voltage		Vcc = 2.7-5.5 V (Note 1)		
		Vcc = 2.7–3.6 V (Note 2)		
VPP voltage (For Prog	ram/Erase)	4.5-5.5 V		
Flash memory mode		3 modes (Parallel I/O mode, Standard serial I/O mode, CPU rewrite mode)		
Erase block division User ROM area		1 block (32 Kbytes)		
	Boot ROM area	1 block (4 Kbytes) (Note 3)		
Program method		Byte program		
Erase method		Batch erasing		
Program/Erase contro	ol method	Program/Erase control by software command		
Number of commands		6 commands		
Number of program/E	rase times	100 times		
ROM code protection		Available in parallel I/O mode and standard serial I/O mode		

Notes 1: The power source voltage must be Vcc = 4.5-5.5 V at program and erase operation.

2: The power source voltage can be Vcc = 3.0-3.6 V also at program and erase operation.

3: The Boot ROM area has had a standard serial I/O mode control program stored in it when shipped from the factory. This Boot ROM area can be rewritten in only parallel I/O mode.

(1) CPU Rewrite Mode

In CPU rewrite mode, the internal flash memory can be operated on (read, program, or erase) under control of the Central Processing Unit (CPU).

In CPU rewrite mode, only the User ROM area shown in Figure 57 can be rewritten; the Boot ROM area cannot be rewritten. Make sure the program and block erase commands are issued for only the User ROM area and each block area.

The control program for CPU rewrite mode can be stored in either User ROM or Boot ROM area. In the CPU rewrite mode, because the flash memory cannot be read from the CPU, the rewrite control program must be transferred to internal RAM area to be executed before it can be executed.

Microcomputer Mode and Boot Mode

The control program for CPU rewrite mode must be written into the User ROM or Boot ROM area in parallel I/O mode beforehand. (If the control program is written into the Boot ROM area, the standard serial I/O mode becomes unusable.)

See Figure 57 for details about the Boot ROM area.

Normal microcomputer mode is entered when the microcomputer is reset with pulling CNVss pin low. In this case, the CPU starts operating using the control program in the User ROM area. When the microcomputer is reset by pulling the P41/INTo pin high, the CNVss pin high, the CPU starts operating using the control program in the Boot ROM area (program start address is FFFC16, FFFD16 fixation). This mode is called the "Boot" mode.

Block Address

Block addresses refer to the maximum address of each block. These addresses are used in the block erase command. In case of the M38517F8, it has only one block.

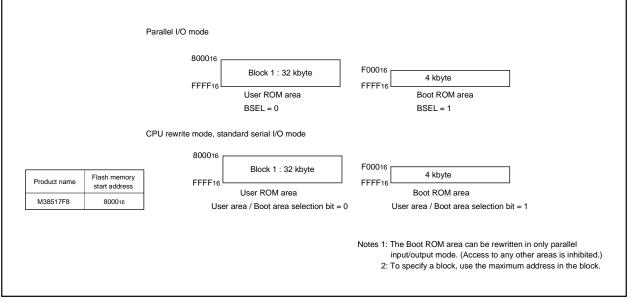


Fig. 57 Block diagram of built-in flash memory



Outline Performance (CPU Rewrite Mode)

CPU rewrite mode is usable in the single-chip or Boot mode. The only User ROM area can be rewritten in CPU rewrite mode.

In CPU rewrite mode, the CPU erases, programs and reads the internal flash memory by executing software commands. This rewrite control program must be transferred to the RAM before it can be executed.

The MCU enters CPU rewrite mode by applying 5 V \pm 0.5 V to the CNVss pin and setting "1" to the CPU Rewrite Mode Select Bit (bit 1 of address 0FFE16). Software commands are accepted once the mode is entered.

Use software commands to control program and erase operations. Whether a program or erase operation has terminated normally or in error can be verified by reading the status register.

Figure 58 shows the flash memory control register.

Bit 0 is the RY/BY status flag used exclusively to read the operating status of the flash memory. During programming and erase operations, it is "0" (busy). Otherwise, it is "1" (ready).

Bit 1 is the CPU Rewrite Mode Select Bit. When this bit is set to "1", the MCU enters CPU rewrite mode. Software commands are accepted once the mode is entered. In CPU rewrite mode, the CPU becomes unable to access the internal flash memory directly. Therefore, use the control program in the RAM for write to bit 1. To set this bit to "1", it is necessary to write "0" and then write "1" in succession. The bit can be set to "0" by only writing "0".

Bit 2 is the CPU Rewrite Mode Entry Flag. This flag indicates "1" in CPU rewrite mode, so that reading this flag can check whether CPU rewrite mode has been entered or not.

Bit 3 is the flash memory reset bit used to reset the control circuit of internal flash memory. This bit is used when exiting CPU rewrite mode and when flash memory access has failed. When the CPU Rewrite Mode Select Bit is "1", setting "1" for this bit resets the control circuit. To set this bit to "1", it is necessary to write "0" and then write "1" in succession. To release the reset, it is necessary to set this bit to "0".

Bit 4 is the User Area/Boot Area Select Bit. When this bit is set to "1", Boot ROM area is accessed, and CPU rewrite mode in Boot ROM area is available. In Boot mode, this bit is set to "1" automatically. Reprogramming of this bit must be in the RAM.

Figure 59 shows a flowchart for setting/releasing CPU rewrite mode.

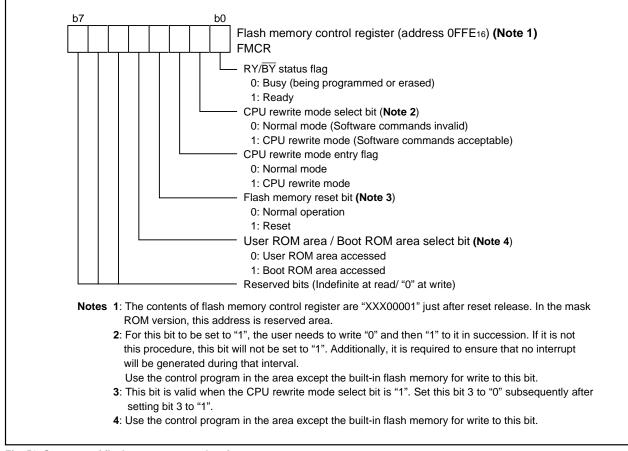
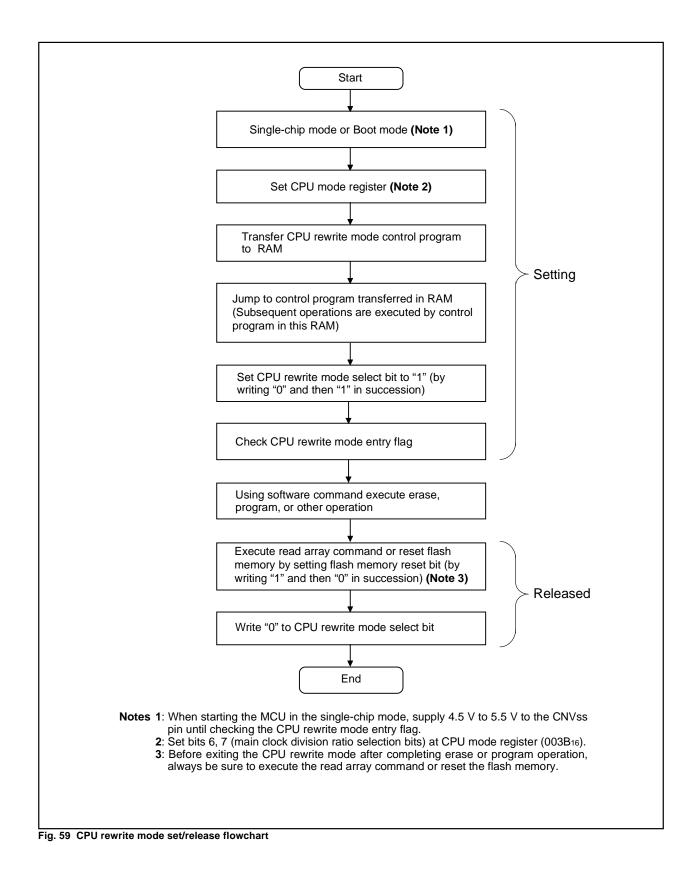


Fig. 58 Structure of flash memory control register



Precautions on CPU Rewrite Mode

Described below are the precautions to be observed when rewriting the flash memory in CPU rewrite mode.

(1) Operation speed

During CPU rewrite mode, set the internal clock frequency 4.0 MHz or less using the main clock division ratio selection bits (bit 6, 7 at 003B16).

(2) Instructions inhibited against use

The instructions which refer to the internal data of the flash memory cannot be used during CPU rewrite mode .

(3) Interrupts inhibited against use

The interrupts cannot be used during CPU rewrite mode because they refer to the internal data of the flash memory.

(4) Watchdog timer

In case of the watchdog timer has been running already, the internal reset generated by watchdog timer underflow does not happen, because of watchdog timer is always clearing during program or erase operation.

(5) Reset

Reset is always valid. In case of CNVss = H when reset is released, boot mode is active. So the program starts from the address contained in address FFFC16 and FFFD16 in boot ROM area.

Software Commands (CPU Rewrite Mode)

Table 16 lists the software commands.

After setting the CPU Rewrite Mode Select Bit of the flash memory control register to "1", execute a software command to specify an erase or program operation.

Each software command is explained below.

Read Array Command (FF16)

The read array mode is entered by writing the command code "FF16" in the first bus cycle. When an address to be read is input in one of the bus cycles that follow, the contents of the specified address are read out at the data bus (D0 to D7).

The read array mode is retained intact until another command is written.

Read Status Register Command (7016)

The read status register mode is entered by writing the command code "7016" in the first bus cycle. The contents of the status register are read out at the data bus (D0 to D7) by a read in the second bus cycle.

The status register is explained in the next section.

Clear Status Register Command (5016)

This command is used to clear the bits SR1, SR4, and SR5 of the status register after they have been set. These bits indicate that operation has ended in an error. To use this command, write the command code "5016" in the first bus cycle.

• Program Command (4016)

Program operation starts when the command code "4016" is written in the first bus cycle. Then, if the address and data to program are written in the 2nd bus cycle, program operation (data programming and verification) will start.

Whether the write operation is completed can be confirmed by reading the status register or the RY/BY Status Flag of the flash memory control register. When the program starts, the read status

register mode is entered automatically and the contents of the status register is read at the data bus (Do to D7). The status register bit 7 (SR7) is set to "0" at the same time the write operation starts and is returned to "1" upon completion of the write operation. In this case, the read status register mode remains active until the next command is written.

The RY/BY Status Flag is "0" (busy) during write operation and "1" (ready) when the write operation is completed as is the status register bit 7.

At program end, program results can be checked by reading bit 4 (SR4) of the status register.

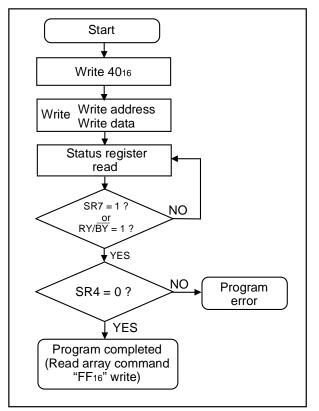


Fig. 60 Program flowchart

		First bus cycle			Second bus cycle		
Command	Cycle number	Mode	Address	Data (Do to D7)	Mode	Address	Data (Do to D7)
Read array	1	Write	X (Note 1)	FF16			
Read status register	2	Write	Х	7016	Read	Х	SRD (Note 2)
Clear status register	1	Write	Х	5016			
Program	2	Write	Х	4016	Write	WA (Note 3)	WD (Note 3)
Erase all blocks	2	Write	Х	2016	Write	Х	2016
Block erase	2	Write	Х	2016	Write	BA (Note 4)	D016

Notes 1: X denotes a given address in the User ROM area .

2: SRD = Status Register Data

3: WA = Write Address, WD = Write Data

4: BA = Block Address to be erased (Input the maximum address of each block.)

RENESAS

Table 16 List of software commands (CPU rewrite mode)

Erase All Blocks Command (2016/2016)

By writing the command code "2016" in the first bus cycle and the confirmation command code "2016" in the second bus cycle that follows, the operation of erase all blocks (erase and erase verify) starts.

Whether the erase all blocks command is terminated can be confirmed by reading the status register or the RY/BŸ Status Flag of flash memory control register. When the erase all blocks operation starts, the read status register mode is entered automatically and the contents of the status register can be read out at the data bus (Do to D7). The status register bit 7 (SR7) is set to "0" at the same time the erase operation starts and is returned to "1" upon completion of the erase operation. In this case, the read status register mode remains active until another command is written.

The RY/BY Status Flag is "0" during erase operation and "1" when the erase operation is completed as is the status register bit 7 (SR7).

After the erase all blocks end, erase results can be checked by reading bit 5 (SRS) of the status register. For details, refer to the section where the status register is detailed.

Block Erase Command (2016/D016)

By writing the command code "2016" in the first bus cycle and the confirmation command code "D016" and the block address in the second bus cycle that follows, the block erase (erase and erase verify) operation starts for the block address of the flash memory to be specified.

Whether the block erase operation is completed can be confirmed by reading the status register or the RY/BY Status Flag of flash memory control register. At the same time the block erase operation starts, the read status register mode is automatically entered, so that the contents of the status register can be read out. The status register bit 7 (SR7) is set to "0" at the same time the block erase operation starts and is returned to "1" upon completion of the block erase operation. In this case, the read status register mode remains active until the read array command (FF16) is written.

The RY/BY Status Flag is "0" during block erase operation and "1" when the block erase operation is completed as is the status register bit 7.

After the block erase ends, erase results can be checked by reading bit 5 (SRS) of the status register. For details, refer to the section where the status register is detailed.

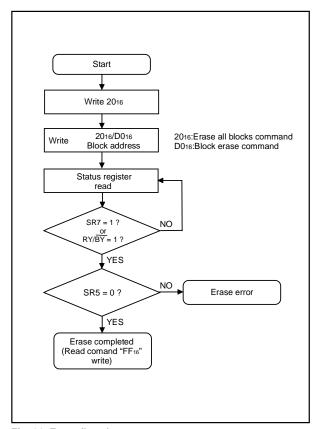


Fig. 61 Erase flowchart



Status Register (SRD)

The status register shows the operating status of the flash memory and whether erase operations and programs ended successfully or in error. It can be read in the following ways:

- By reading an arbitrary address from the User ROM area after writing the read status register command (7016)
- (2) By reading an arbitrary address from the User ROM area in the period from when the program starts or erase operation starts to when the read array command (FF16) is input.

Also, the status register can be cleared by writing the clear status register command (5016).

After reset, the status register is set to "8016".

Table 17 shows the status register. Each bit in this register is explained below.

•Sequencer status (SR7)

The sequencer status indicates the operating status of the flash memory. This bit is set to "0" (busy) during write or erase operation and is set to "1" when these operations ends.

After power-on, the sequencer status is set to "1" (ready).

•Erase status (SR5)

The erase status indicates the operating status of erase operation. If an erase error occurs, it is set to "1". When the erase status is cleared, it is set to "0".

•Program status (SR4)

The program status indicates the operating status of write operation. When a write error occurs, it is set to "1". The program status is set to "0" when it is cleared.

If "1" is written for any of the SR5 and SR4 bits, the program, erase all blocks, and block erase commands are not accepted. Before executing these commands, execute the clear status register command (5016) and clear the status register.

Also, if any commands are not correct, both SR5 and SR4 are set to "1".

Table 17 Definition of each bit in status register (SRD)

Symbol	Status name	Definition		
Gymbol	Status name	"1"	"0"	
SR7 (bit7)	Sequencer status	Ready	Busy	
SR6 (bit6)	Reserved	-	-	
SR5 (bit5)	Erase status	Terminated in error	Terminated normally	
SR4 (bit4)	Program status	Terminated in error	Terminated normally	
SR3 (bit3)	Reserved	-	-	
SR2 (bit2)	Reserved	-	-	
SR1 (bit1)	Reserved	-	-	
SR0 (bit0)	Reserved	-	-	

Full Status Check

By performing full status check, it is possible to know the execution results of erase and program operations. Figure 62 shows a

full status check flowchart and the action to be taken when each error occurs.

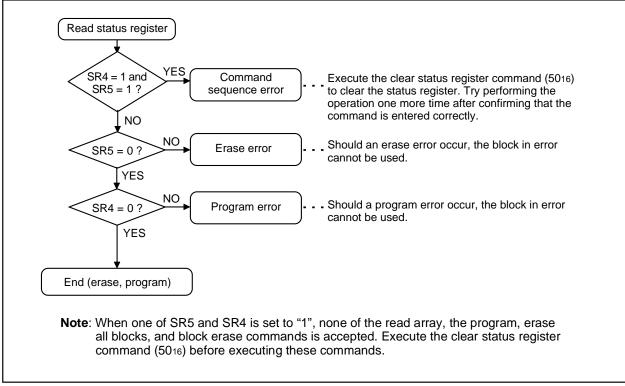


Fig. 62 Full status check flowchart and remedial procedure for errors



Functions To Inhibit Rewriting Flash Memory Version

To prevent the contents of internal flash memory from being read out or rewritten easily, this MCU incorporates a ROM code protect function for use in parallel I/O mode and an ID code check function for use in standard serial I/O mode.

●ROM Code Protect Function (in Parallel I/O Mode)

The ROM code protect function is the function to inhibit reading out or modifying the contents of internal flash memory by using the ROM code protect control (address FFDB16) in parallel I/O mode. Figure 63 shows the ROM code protect control (address FFDB16). (This address exists in the User ROM area.) If one or both of the pair of ROM Code Protect Bits is set to "0", the ROM code protect is turned on, so that the contents of internal flash memory are protected against readout and modification. The ROM code protect is implemented in two levels. If level 2 is selected, the flash memory is protected even against readout by a shipment inspection LSI tester, etc. When an attempt is made to select both level 1 and level 2, level 2 is selected by default. If both of the two ROM Code Protect Reset Bits are set to "00", the ROM code protect is turned off, so that the contents of internal flash memory can be read out or modified. Once the ROM code protect Reset Bits cannot be modified in parallel I/O mode. Use the serial I/O or CPU rewrite mode to rewrite the contents of the ROM Code Protect Reset Bits.

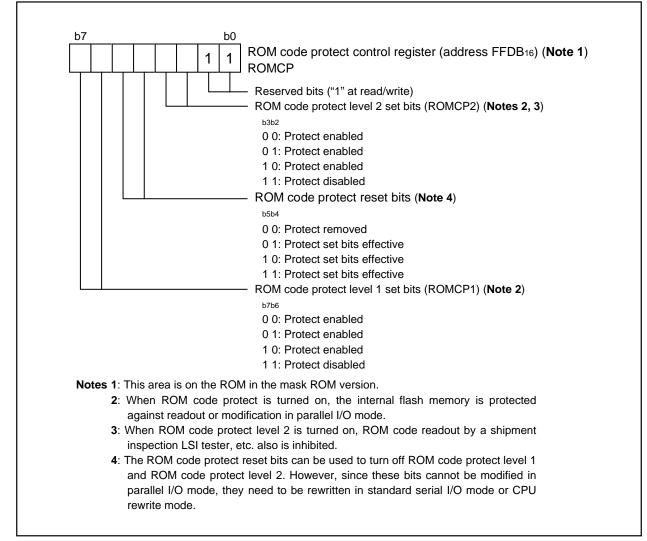


Fig. 63 Structure of ROM code protect control

ID Code Check Function (in Standard serial I/O mode)

Use this function in standard serial I/O mode. When the contents of the flash memory are not blank, the ID code sent from the programmer is compared with the ID code written in the flash memory to see if they match. If the ID codes do not match, the commands sent from the programmer are not accepted. The ID code consists of 8-bit data, and its areas are FFD416 to FFDA16. Write a program which has had the ID code preset at these addresses to the flash memory.

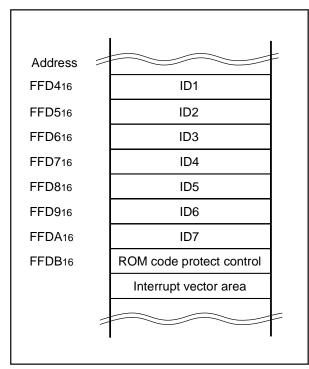


Fig. 64 ID code store addresses



(2) Parallel I/O Mode

Parallel I/O mode is the mode which parallel output and input software command, address, and data required for the operations (read, program, erase, etc.) to a built-in flash memory. Use the exclusive external equipment flash programmer which supports the 3851 Group (flash memory version). Refer to each programmer maker's handling manual for the details of the usage.

User ROM and Boot ROM Areas

In parallel I/O mode, the user ROM and boot ROM areas shown in Figure 57 can be rewritten. Both areas of flash memory can be operated on in the same way.

Program and block erase operations can be performed in the user ROM area. The user ROM area and its block is shown in Figure 57.

The boot ROM area is 4 Kbytes in size. It is located at addresses F00016 through FFFF16. Make sure program and block erase operations are always performed within this address range. (Access to any location outside this address range is prohibited.)

In the Boot ROM area, an erase block operation is applied to only one 4 Kbyte block. The boot ROM area has had a standard serial I/O mode control program stored in it when shipped from the Renesas factory. Therefore, using the device in standard serial I/O mode, you do not need to write to the boot ROM area.

(3) Standard serial I/O Mode

The standard serial I/O mode inputs and outputs the software commands, addresses and data needed to operate (read, program, erase, etc.) the internal flash memory. This I/O is clock synchronized serial. This mode requires the exclusive external equipment (serial programmer).

The standard serial I/O mode is different from the parallel I/O mode in that the CPU controls flash memory rewrite (uses the CPU rewrite mode), rewrite data input and so forth. The standard serial I/O mode is started by connecting "H" to the P26 (SCLK1) pin and "H" to the P41 (INT0) pin and "H" to the CNVss pin (apply 4.5 V to 5.5 V to Vpp from an external source), and releasing the reset operation. (In the ordinary microcomputer mode, set CNVss pin to "L" level.)

This control program is written in the Boot ROM area when the product is shipped from Renesas Technology Corporation. Accordingly, make note of the fact that the standard serial I/O mode cannot be used if the Boot ROM area is rewritten in parallel I/O mode. Figure 65 shows the pin connection for the standard serial I/O mode.

In standard serial I/O mode, serial data I/O uses the four serial I/O pins SCLK1, RxD, TxD and $\overline{\text{SRDY1}}$ (BUSY). The SCLK1 pin is the transfer clock input pin through which an external transfer clock is input. The TxD pin is for CMOS output. The $\overline{\text{SRDY1}}$ (BUSY) pin outputs "L" level when ready for reception and "H" level when reception starts.

Serial data I/O is transferred serially in 8-bit units.

In standard serial I/O mode, only the User ROM area shown in Figure 57 can be rewritten. The Boot ROM area cannot.

In standard serial I/O mode, a 7-byte ID code is used. When there is data in the flash memory, commands sent from the peripheral unit (programmer) are not accepted unless the ID code matches.

Outline Performance (Standard Serial I/O Mode)

In standard serial I/O mode, software commands, addresses and data are input and output between the MCU and peripheral units (serial programmer, etc.) using 4-wire clock-synchronized serial I/O (serial I/O1).

In reception, software commands, addresses and program data are synchronized with the rise of the transfer clock that is input to the SCLK1 pin, and are then input to the MCU via the RxD pin. In transmission, the read data and status are synchronized with the fall of the transfer clock, and output from the TxD pin.

The TxD pin is for CMOS output. Transfer is in 8-bit units with LSB first.

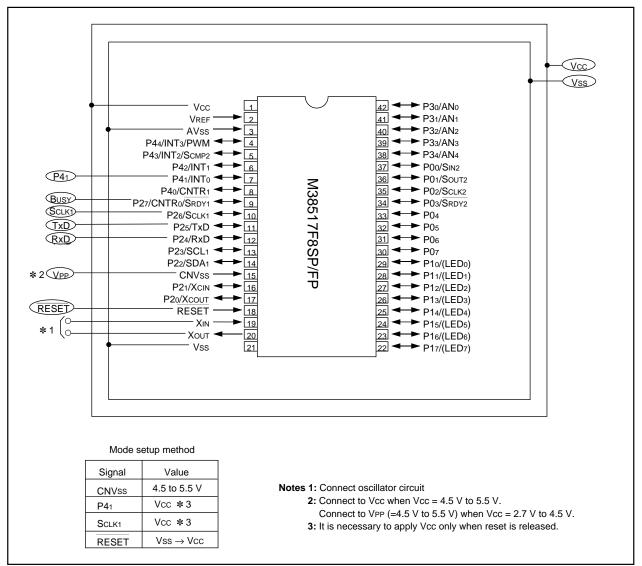
When busy, such as during transmission, reception, erasing or program execution, the $\overline{SRDY1}$ (BUSY) pin is "H" level. Accordingly, always start the next transfer after the $\overline{SRDY1}$ (BUSY) pin is "L" level.

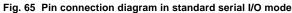
Also, data and status registers in a memory can be read after inputting software commands. Status, such as the operating state of the flash memory or whether a program or erase operation ended successfully or not, can be checked by reading the status register. Here following explains software commands, status registers, etc.

Pin	Name	I/O	Description
Vcc,Vss	Power input		Apply program/erase protection voltage to Vcc pin and 0 V to Vss pin.
CNVss	CNVss	I	Connect to Vcc when Vcc = 4.5 V to 5.5 V. Connect to Vpp (= 4.5 V to 5.5 V) when Vcc = 2.7 V to 4.5 V.
RESET	Reset input	I	Reset input pin. While reset is "L" level, a 20 cycle or longer clock must be input to XIN pin.
XIN	Clock input	I	Connect a ceramic resonator or crystal oscillator between XIN and XOUT pins. To input an externally generated clock, input it to XIN pin
Xout	Clock output	0	and open Xout pin.
AVss	Analog power supply input		Connect AVss to Vss .
Vref	Reference voltage input	I	Enter the reference voltage for AD from this pin, or open.
P00 to P07	Input port P0	I	Input "H" or "L", or open.
P10 to P17	Input port P1	I	Input "H" or "L", or open.
P20 to P23	Input port P2	I	Input "H" or "L", or open.
P24	RxD input	I	This pin is for serial data input.
P25	TxD output	0	This pin is for serial data output.
P26	Sclk1 input	I	This pin is for serial clock input.
P27	BUSY output	0	This pin is for BUSY signal output.
P30 to P34	Input port P3	I	Input "H" or "L", or open.
P40, P42 to P44	Input port P4	I	Input "H" or "L", or open.
P41	Input port P4	1	Input "H" when RESET is released only.

Table 18 Description of pin function (Standard Serial I/O Mode)









Software Commands (Standard Serial I/O Mode)

commands via the RxD pin. Software commands are explained here below.

Table 19 lists software commands. In standard serial I/O mode, erase, program and read are controlled by transferring software

Table 19 Software commands (Standard serial I/O mode)

	Control command	1st byte transfer	2nd byte	3rd byte	4th byte	5th byte	6th byte		When ID is not verified
1	Page read	FF16	Address (middle)	Address (high)	Data output	Data output	Data output	Data output to 259th byte	Not acceptable
2	Page program	4116	Address (middle)	Address (high)	Data input	Data input	Data input	Data input to 259th byte	Not acceptable
3	Erase all blocks	A716	D016						Not acceptable
4	Read status register	7016	SRD output	SRD1 output					Acceptable
5	Clear status register	5016							Not acceptable
6	ID code check	F516	Address (low)	Address (middle)	Address (high)	ID size	ID1	To ID7	Acceptable
7	Download function	FA16	Size (low)	Size (high)	Check- sum	Data input	To required number of times		Not acceptable
8	Version data output function	FB16	Version data output	Version data output	Version data output	Version data output	Version data output	Version data output to 9th byte	Acceptable

Notes1: Shading indicates transfer from the internal flash memory microcomputer to a programmer. All other data is transferred from an external equipment (programmer) to the internal flash memory microcomputer.

2: SRD refers to status register data. SRD1 refers to status register 1 data.

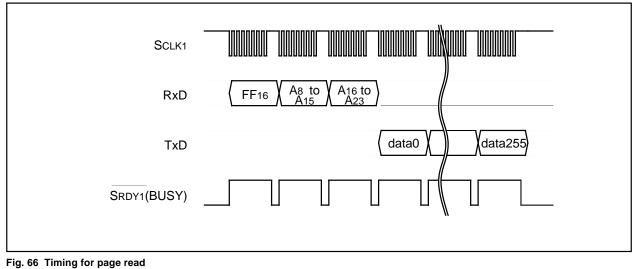
3: All commands can be accepted when the flash memory is totally blank.

4: Address high must be "0016".

Page Read Command

This command reads the specified page (256 bytes) in the flash memory sequentially one byte at a time. Execute the page read command as explained here following.

- (1) Transfer the "FF16" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 with the 2nd and 3rd bytes respectively.
- (3) From the 4th byte onward, data (Do to D7) for the page (256 bytes) specified with addresses A8 to A23 will be output sequentially from the smallest address first synchronized with the fall of the clock.



•Read Status Register Command

This command reads status information. When the "7016" command code is transferred with the 1st byte, the contents of the status register (SRD) with the 2nd byte and the contents of status register 1 (SRD1) with the 3rd byte are read.

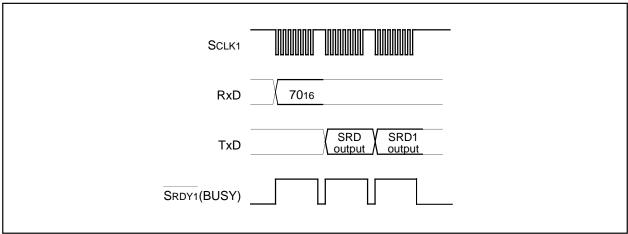


Fig. 67 Timing for reading status register

•Clear Status Register Command

This command clears the bits (SR4, SR5) which are set when the status register operation ends in error. When the "5016" command code is sent with the 1st byte, the aforementioned bits are cleared. When the clear status register operation ends, the SRDY1 (BUSY) signal changes from "H" to "L" level.

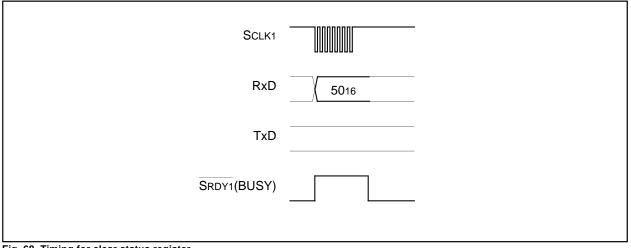


Fig. 68 Timing for clear status register

Page Program Command

This command writes the specified page (256 bytes) in the flash memory sequentially one byte at a time. Execute the page program command as explained here following.

- (1) Transfer the "4116" command code with the 1st byte.
- (2) Transfer addresses A8 to A15 and A16 to A23 ("0016") with the 2nd and 3rd bytes respectively.
- (3) From the 4th byte onward, as write data (Do to D7) for the page (256 bytes) specified with addresses A8 to A23 is input sequentially from the smallest address first, that page is automatically written.

When reception setup for the next 256 bytes ends, the $\overline{\text{SRDY1}}$ (BUSY) signal changes from "H" to "L" level. The result of the page program can be known by reading the status register. For more information, see the section on the status register.

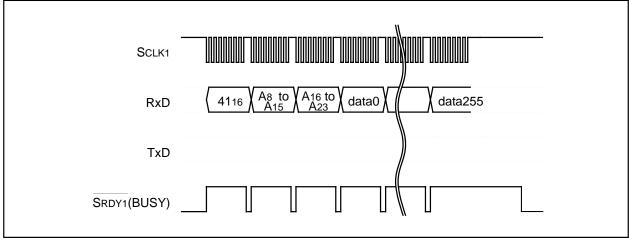


Fig. 69 Timing for page program



•Erase All Blocks Command

This command erases the contents of all blocks. Execute the erase all blocks command as explained here following.

- (1) Transfer the "A716" command code with the 1st byte.
- (2) Transfer the verify command code "D016" with the 2nd byte. With the verify command code, the erase operation will start and continue for all blocks in the flash memory.

When erase all blocks end, the $\overline{\text{SRDY1}}$ (BUSY) signal changes from "H" to "L" level. The result of the erase operation can be known by reading the status register.

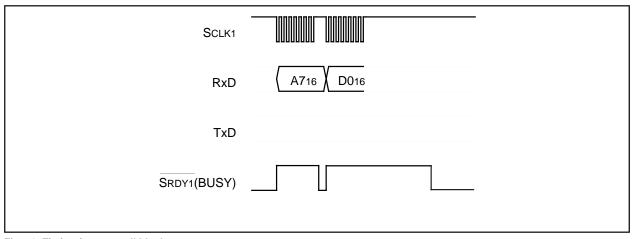


Fig. 70 Timing for erase all blocks



Download Command

This command downloads a program to the RAM for execution. Execute the download command as explained here following.

- (1) Transfer the "FA16" command code with the 1st byte.
- (2) Transfer the program size with the 2nd and 3rd bytes.
- (3) Transfer the check sum with the 4th byte. The check sum is added to all data sent with the 5th byte onward.
- (4) The program to execute is sent with the 5th byte onward.

When all data has been transmitted, if the check sum matches, the downloaded program is executed. The size of the program will vary according to the internal RAM.

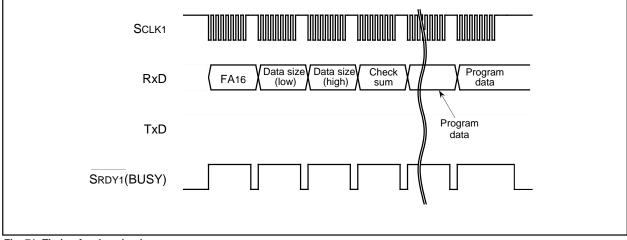


Fig. 71 Timing for download

Version Information Output Command

This command outputs the version information of the control program stored in the Boot ROM area. Execute the version information output command as explained here following.

- (1) Transfer the "FB16" command code with the 1st byte.
- (2) The version information will be output from the 2nd byte onward. This data is composed of 8 ASCII code characters.

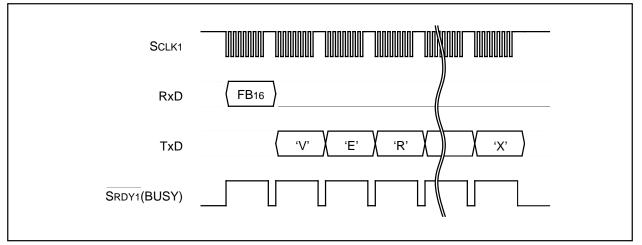


Fig. 72 Timing for version information output



ID Check

This command checks the ID code. Execute the boot ID check command as explained here following.

- (1) Transfer the "F516" command code with the 1st byte.
- (2) Transfer addresses A0 to A7, A8 to A15 and A16 to A23 ("0016") of the 1st byte of the ID code with the 2nd, 3rd, and 4th bytes respectively.
- (3) Transfer the number of data sets of the ID code with the 5th byte.
- (4) Transfer the ID code with the 6th byte onward, starting with the 1st byte of the code.

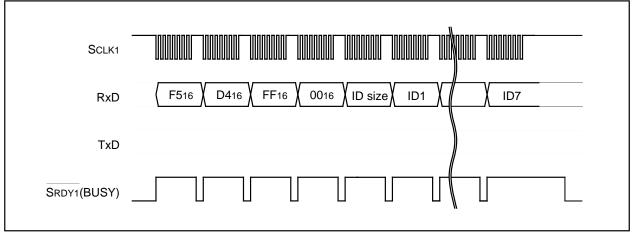


Fig. 73 Timing for ID check

ID Code

When the flash memory is not blank, the ID code sent from the serial programmer and the ID code written in the flash memory are compared to see if they match. If the codes do not match, the command sent from the serial programmer is not accepted. An ID code contains 8 bits of data. Area is, from the 1st byte, addresses FFD416 to FFDA16. Write a program into the flash memory, which already has the ID code set for these addresses.

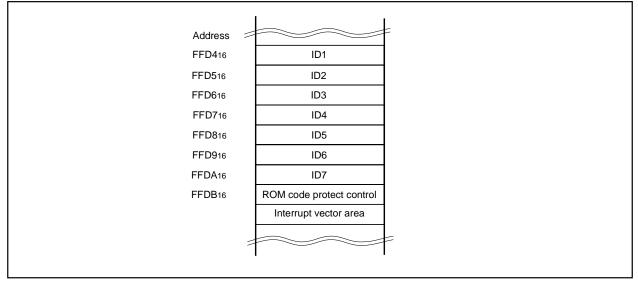


Fig. 74 ID code storage addresses

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Status Register (SRD)

The status register indicates operating status of the flash memory and status such as whether an erase operation or a program ended successfully or in error. It can be read by writing the read status register command (7016). Also, the status register is cleared by writing the clear status register command (5016). Table 20 lists the definition of each status register bit. After releasing the reset, the status register becomes "8016".

•Sequencer status (SR7)

The sequencer status indicates the operating status of the flash memory.

After power-on and recover from deep power down mode, the sequencer status is set to "1" (ready).

This status bit is set to "0" (busy) during write or erase operation and is set to "1" upon completion of these operations.

•Erase status (SR5)

The erase status indicates the operating status of erase operation. If an erase error occurs, it is set to "1". When the erase status is cleared, it is set to "0".

•Program status (SR4)

The program status indicates the operating status of write operation. If a program error occurs, it is set to "1". When the program status is cleared, it is set to "0".

Table 20 Definition of each bit of status register (SRD)

		Definition		
SRD0 bits	Status name	"1"	"0"	
SR7 (bit7)	Sequencer status	Ready	Busy	
SR6 (bit6)	Reserved	-	-	
SR5 (bit5)	Erase status	Terminated in error	Terminated normally	
SR4 (bit4)	Program status	Terminated in error	Terminated normally	
SR3 (bit3)	Reserved	-	-	
SR2 (bit2)	Reserved	-	-	
SR1 (bit1)	Reserved	-	-	
SR0 (bit0)	Reserved	-	-	



•Status Register 1 (SRD1)

The status register 1 indicates the status of serial communications, results from ID checks and results from check sum comparisons. It can be read after the status register (SRD) by writing the read status register command (7016). Also, status register 1 is cleared by writing the clear status register command (5016). Table 21 lists the definition of each status register 1 bit. This register becomes "0016" when power is turned on and the flag status is maintained even after the reset.

•Boot update completed bit (SR15)

This flag indicates whether the control program was downloaded to the RAM or not, using the download function.

•Check sum consistency bit (SR12)

This flag indicates whether the check sum matches or not when a program, is downloaded for execution using the download function.

•ID check completed bits (SR11 and SR10)

These flags indicate the result of ID checks. Some commands cannot be accepted without an ID code check.

•Data reception time out (SR9)

This flag indicates when a time out error is generated during data reception. If this flag is attached during data reception, the received data is discarded and the MCU returns to the command wait state.

Table 21 Definition of each bit of status register 1 (SRD1)

SRD1 bits	Status name	Definition	
		"1"	"0"
SR15 (bit7)	Boot update completed bit	Update completed	d Not Update
SR14 (bit6)	Reserved	-	-
SR13 (bit5)	Reserved	-	-
SR12 (bit4)	Checksum match bit	Match	Mismatch
SR11 (bit3)	ID check completed bits	00	Not verified
SR10 (bit2)		01	Verification mismatch
		10	Reserved
		11	Verified
SR9 (bit1)	Data reception time out	Time out	Normal operation
SR8 (bit0)	Reserved	-	-



Full Status Check

Results from executed erase and program operations can be known by running a full status check. Figure 75 shows a flowchart of the full status check and explains how to remedy errors which occur.

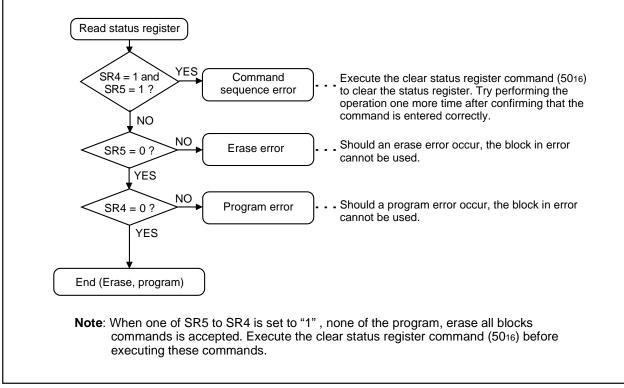


Fig. 75 Full status check flowchart and remedial procedure for errors



Example Circuit Application for Standard Serial I/O Mode

Figure 76 shows a circuit application for the standard serial I/O mode. Control pins will vary according to a programmer, therefore see a programmer manual for more information.

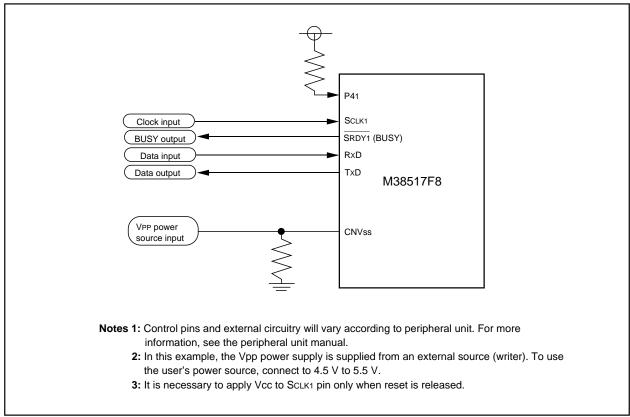


Fig. 76 Example circuit application for standard serial I/O mode



Flash memory Electrical characteristics

Table 22 Absolute maximum ratings

Symbol	Parameter	Conditions	Ratings	Unit
Vcc	Power source voltage		-0.3 to 6.5	V
VI	Input voltage P00–P07, P10–P17, P20, P21, P24–P27, P30–P34, P40–P44, VREF Input voltage P22, P23 All voltages are based on Vss.		-0.3 to Vcc +0.3	V
Vi	Input voltage P22, P23		-0.3 to 5.8	V
Vi	Input voltage RESET, XIN	Output transistors are cut off.	-0.3 to Vcc +0.3	V
Vi	Input voltage CNVss		-0.3 to 6.5	V
Vo	Output voltage P00–P07, P10–P17, P20, P21, P24–P27, P30–P34, P40–P44, XOUT		-0.3 to Vcc +0.3	V
Vo	Output voltage P22, P23		-0.3 to 5.8	V
Pd	Power dissipation	Ta = 25 °C	1000 (Note)	mW
Topr	Operating temperature		25±5	°C
Tstg	Storage temperature	1	-40 to 125	°C

Note: The rating becomes 300 mW at the 42P2R-A/E package.

Table 23 Flash memory mode Electrical characteristics (Ta = 25° C, Vcc = 4.5 to 5.5V unless otherwise noted)

			Limits				
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
IPP1	VPP power source current (read)	VPP = VCC			100	μΑ	
IPP2	VPP power source current (program)	VPP = VCC			60	mA	
IPP3	VPP power source current (erase)	VPP = VCC			30	mA	
Vpp	VPP power source voltage		4.5		5.5	V	
Vcc	Vcc power source voltage	Microcomputer mode operation at Vcc = 2.7 to 5.5V	4.5		5.5	V	
		Microcomputer mode operation at Vcc = 2.7 to 3.6V	3.0		3.6	V	

NOTES ON PROGRAMMING **Processor Status Register**

The contents of the processor status register (PS) after a reset are undefined, except for the interrupt disable flag (I) which is "1". After a reset, initialize flags which affect program execution. In particular, it is essential to initialize the index X mode (T) and the decimal mode (D) flags because of their effect on calculations.

Interrupts

The contents of the interrupt request bits do not change immediately after they have been written. After writing to an interrupt request register, execute at least one instruction before performing a BBC or BBS instruction.

Decimal Calculations

- To calculate in decimal notation, set the decimal mode flag (D) to "1", then execute an ADC or SBC instruction. After executing an ADC or SBC instruction, execute at least one instruction before executing a SEC, CLC, or CLD instruction.
- In decimal mode, the values of the negative (N), overflow (V), and zero (Z) flags are invalid.

Timers

If a value n (between 0 and 255) is written to a timer latch, the frequency division ratio is 1/(n+1).

Multiplication and Division Instructions

- The index X mode (T) and the decimal mode (D) flags do not affect the MUL and DIV instruction.
- · The execution of these instructions does not change the contents of the processor status register.

Ports

The contents of the port direction registers cannot be read. The following cannot be used:

- The data transfer instruction (LDA, etc.)
- The operation instruction when the index X mode flag (T) is "1"
- The addressing mode which uses the value of a direction register as an index
- The bit-test instruction (BBC or BBS, etc.) to a direction register
- The read-modify-write instructions (ROR, CLB, or SEB, etc.) to a direction register.

Use instructions such as LDM and STA, etc., to set the port direction registers.

Serial I/O

In serial I/O1 (clock synchronous mode), if the receive side is using an external clock and it is to output the SRDY1 signal, set the transmit enable bit, the receive enable bit, and the SRDY1 output enable bit to "1".

Serial I/O1 continues to output the final bit from the TxD pin after transmission is completed.

SOUT2 pin for serial I/O2 goes to high impedance after transmission is completed.

When an external clock is used as synchronous clock in serial I/O1 or serial I/O2, write transmission data to the transmit buffer register or serial I/O2 register while the transfer clock is "H".

A-D Converter

The comparator uses capacitive coupling amplifier whose charge will be lost if the clock frequency is too low.

Therefore, make sure that f(XIN) in the middle/high-speed mode is at least on 500 kHz during an A-D conversion.

Do not execute the STP instruction during an A-D conversion.

Instruction Execution Time

The instruction execution time is obtained by multiplying the frequency of the internal clock ϕ by the number of cycles needed to execute an instruction.

The number of cycles required to execute an instruction is shown in the list of machine instructions.

The frequency of the internal clock ϕ is half of the XIN frequency in high-speed mode.

NOTES ON USAGE

Differences between 3851 group (built-in 16 KB ROM) and 3851 group (built-in 24 KB or more ROM)

- (1) The absolute maximum ratings of 3851 group (built-in 24 KB or more ROM) is smaller than that of 3851 group (built-in 16 KB ROM).
 - •Power source voltage Vcc = -0.3 to 6.5 V
 - CNVss input voltage
 - VI = -0.3 to Vcc +0.3 V (M38514M6, M38517M8)
 - VI = -0.3 to 6.5 V (M38517F8)
- (2) The oscillation circuit constants of XIN-XOUT, XCIN-XCOUT may be some differences between 3851 group (built-in 16 KB ROM) and 3851 group (built-in 24 KB or more ROM).
- (3) Do not write any data to the reserved area and the reserved bit. (Do not change the contents after rest.)
- (4) Fix bit 3 of the CPU mode register to "1".
- (5) Be sure to perform the termination of unused pins.

Handling of Source Pins

In order to avoid a latch-up occurrence, connect a capacitor suitable for high frequencies as bypass capacitor between power source pin (Vcc pin) and GND pin (Vss pin) and between power source pin (Vcc pin) and analog power source input pin (AVss pin). Besides, connect the capacitor to as close as possible. For bypass capacitor which should not be located too far from the pins to be connected, a ceramic capacitor of 0.01 $\mu\text{F}\text{--}0.1\mu\text{F}$ is recommended.

EPROM Version/One Time PROM Version/ Flash Memory Version

The CNVss pin is connected to the internal memory circuit block by a low-ohmic resistance, since it has the multiplexed function to be a programmable power source pin (VPP pin) as well.

To improve the noise reduction, connect a track between CNVss pin and Vss pin or Vcc pin with 1 to 10 k Ω resistance.

The mask ROM version track of CNVss pin has no operational interference even if it is connected to Vss pin or Vcc pin via a resistor.



Electric Characteristic Differences Among Mask ROM, Flash Memory, and One Time PROM Version MCUs

There are differences in electric characteristics, operation margin, noise immunity, and noise radiation among mask ROM, flash memory, and One Time PROM version MCUs due to the differences in the manufacturing processes.

When manufacturing an application system with the flash memory, One Time PROM version and then switching to use of the mask ROM version, perform sufficient evaluations for the commercial samples of the mask ROM version.

DATA REQUIRED FOR MASK ORDERS

The following are necessary when ordering a mask ROM production:

- 1. Mask ROM Order Confirmation Form*
- 2. Mark Specification Form*
- 3. Data to be written to ROM, in EPROM form (three identical copies) or one floppy disk.

DATA REQUIRED FOR One Time PROM PROGRAMMING ORDERS

The following are necessary when ordering a PROM programming service:

- 1. ROM Programming Confirmation Form*
- Mark Specification Form* (only special mark with customer's trade mark logo)
- 3. Data to be programmed to PROM, in EPROM form (three identical copies) or one floppy disk.
- *For the mask ROM confirmation and the mark specifications, refer to the "Renesas Technology " Homepage ROM ordering (http://www.renesas.com/eng/rom).

ROM PROGRAMMING METHOD

The built-in PROM of the blank One Time PROM version and builtin EPROM version can be read or programmed with a general-purpose PROM programmer using a special programming adapter. Set the address of PROM programmer in the user ROM area.

Table 20 Programming adapter

Package	Name of Programming Adapter
42P4B, 42S1B	PCA4738S-42A
42P2R-A/E	PCA4738F-42A

The PROM of the blank One Time PROM version is not tested or screened in the assembly process and following processes. To ensure proper operation after programming, the procedure shown in Figure 77 is recommended to verify programming.

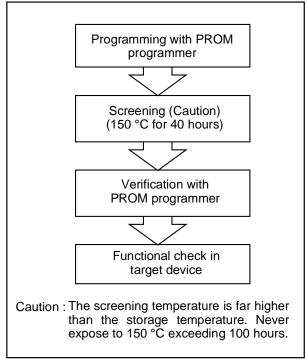


Fig. 77 Programming and testing of One Time PROM version



Electrical characteristics

Absolute maximum ratings

Table 25 Absolute maximum ratings

Symbol	Para	ameter	Conditions	Ratings	Unit
Vcc	Power source voltage			-0.3 to 6.5	V
VI		07, P10–P17, P20, P21, 27, P30–P34, P40–P44,		-0.3 to Vcc +0.3	V
Vi	Input voltage P22, P	23		-0.3 to 5.8	V
VI	Input voltage RESE	Γ, XIN		-0.3 to Vcc +0.3	V
VI	Input voltage CNVss	M38514M6, M38514M8	All voltages are based on Vss.	-0.3 to Vcc +0.3	V
		M38514E6	Output transistors are cut off.	-0.3 to 13	V
		M38517F8		-0.3 to 6.5	V
Vo		07, P10–P17, P20, P21, 27, P30–P34, P40–P44,		-0.3 to Vcc +0.3	v
Vo	Output voltage P22, P2	23		-0.3 to 5.8	V
Pd	Power dissipation		Ta = 25 °C	1000 (Note)	mW
Topr	Operating temperature)		-20 to 85	°C
Tstg	Storage temperature		1	-40 to 125	°C

Note : The rating becomes 300mW at the 42P2R-A/E package.



Recommended operating conditions

 Table 26 Recommended operating conditions (1)

(Vcc = 2.7 to 5.5 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol		Parameter			Limits			Unit
Gymbol					Min.	Тур.	Max.	01111
Vcc	Power source voltage	8 MHz (high-speed mode)		4.0	5.0	5.5	V	
		8 MHz (middle-speed mode),	8 MHz (middle-speed mode), 4 MHz(high-speed mode)		2.7	5.0	5.5	V
Vss	Power source voltage					0		V
Vref	A-D convert reference volt	age			2.0		Vcc	V
AVss	Analog power source volta	ige			0	0		V
VIA	Analog input voltage	AN0-AN4			AVss		Vcc	V
Vih	"H" input voltage	P00–P07, P10–P17, F	20-	P27, P30–P34, P40–P44	0.8Vcc		Vcc	V
Viн	"H" input voltage (when I ²	C-BUS input level is selected)		SDA1, SCL1	0.7Vcc		5.8	V
				SDA2, SCL2	0.7Vcc		Vcc	V
Viн	"H" input voltage (when SM	MBUS input level is selected)		SDA1, SCL1	1.4		5.8	V
				SDA2, SCL2	1.4		Vcc	V
VIH	"H" input voltage	RESET, XIN, CNVSS			0.8Vcc		Vcc	V
VIL	"L" input voltage	P00–P07, P10–P17, F	> 20-	P27, P30–P34, P40–P44	0		0.2Vcc	V
VIL	"L" input voltage (when I ² C	C-BUS input level is selected)	SD	A1, SDA2, SCL1, SCL2	0		0.3Vcc	V
VIL	"L" input voltage (when SM	IBUS input level is selected)	SD	A1, SDA2, SCL1, SCL2	0		0.6	V
VIL	"L" input voltage	RESET , CNVss			0		0.2Vcc	V
VIL	"L" input voltage	XIN			0		0.16Vcc	V
Σ IOH(peak)	"H" total peak output curre	nt (Note) P00–P07, P10–P17, F	> 30–	P34			-80	mA
Σ IOH(peak)	"H" total peak output curre	nt (Note) P20, P21, P24–P27, F	> 40-	P44			-80	mA
Σ IOL(peak)	"L" total peak output curre	nt (Note) P00–P07, P30–P34					80	mA
Σ IOL(peak)	"L" total peak output curre	nt (Note) P10–P17					120	mA
Σ IOL(peak)	"L" total peak output curre	nt (Note) P20–P27,P40–P44					80	mA
Σ IOH(avg)	"H" total average output cu	urrent (Note) P00–P07, P10–P1	7, P3	30-P34			-40	mA
Σ IOH(avg)	"H" total average output cu	urrent (Note) P20, P21, P24–P2	27, P4	40-P44			-40	mA
Σ IOL(avg)	"L" total average output cu	rrent (Note) P00–P07, P30–P3	84				40	mA
Σ IOL(avg)	"L" total average output cu	rrent (Note) P10-P17					60	mA
Σ IOL(avg)	"L" total average output cu	rrent (Note) P20-P27,P40-P44	4				40	mA

Note : The total output current is the sum of all the currents flowing through all the applicable ports. The total average current is an average value measured over 100 ms. The total peak current is the peak value of all the currents.

Symbol		Parameter		Limits		Unit
Symbol		Farameter	Min.	Тур.	Max.	
IOH(peak)	"H" peak output current (Note 1)	P00–P07, P10–P17, P20, P21, P24–P27, P30–P34,			-10	mA
		P40–P44				
IOL(peak)	"L" peak output current (Note 1)	P00-P07, P20-P27, P30-P34, P40-P44,			10	mA
		P10–P17			20	mA
IOH(avg)	"H" average output current (Note 2)	P00-P07, P10-P17, P20, P21, P24-P27, P30-P34,			-5	mA
		P40–P44				
IOL(avg)	"L" average output current (Note 2)	P00-P07, P20-P27, P30-P34, P40-P44,			5	mA
		P10–P17			15	mA
f(XIN)	Internal clock oscillation frequency (Vcc = 4.0 to 5.5V) (Note 3)			8	MHz
f(XIN)	Internal clock oscillation frequency (Vcc = 2.7 to 5.5V) (Note 3)			4	MHz

Table 27 Recommended operating conditions (2) (Vcc = 2.7 to 5.5 V, Ta = -20 to 85 °C, unless otherwise noted)

Notes 1: The peak output current is the peak current flowing in each port.

2: The average output current IOL(avg), IOH(avg) are average value measured over 100 ms.

3: When the oscillation frequency has a duty cycle of 50%.

Electrical characteristics

Table 28 Electrical characteristics (1)

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

				Limits		
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Voн	"H" output voltage P00–P07, P10–P17, P20, P21,	IOH = -10 mA Vcc = 4.0-5.5 V	Vcc-2.0			V
	P24–P27, P30–P34, P40–P44 (Note)	IOH = -1.0 mA Vcc = 2.7-5.5 V	Vcc-1.0			V
Vol	"L" output voltage P00–P07, P20–P27, P30–P34,	IOL = 10 mA VCC = 4.0–5.5 V			2.0	V
	P40-P44	IOL = 1.0 mA VCC = 2.7–5.5 V			1.0	V
Vol	"L" output voltage P10–P17	IOL = 20 mA VCC = 4.0–5.5 V			2.0	V
		IOL = 10 mA VCC = 2.7–5.5 V			1.0	V

Note: P25 is measured when the P25/SCL2/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is "0".

		_		Limits		Unit
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	- Unit
VT+-VT-	Hysteresis			0.4		V
	CNTR0, CNTR1, INT0-INT3					
VT+VT-	Hysteresis			0.5		V
	RxD, SCLK1, SIN2, SCLK2					
VT+VT-	Hysteresis RESET			0.5		V
Ін	"H" input current	VI = VCC			5.0	μΑ
	P00–P07, P10–P17, P20, P21,					
	P24-P27, P30-P34, P40-P44					
Ін	"H" input current RESET, CNVss	VI = VCC			5.0	μΑ
Ін	"H" input current XIN	VI = VCC		4		μA
lı∟	"L" input current	VI = VSS			-5.0	μΑ
	P00-P07, P10-P17, P20-P27					
	P30-P34, P40-P44					
lil	"L" input current RESET, CNVss	VI = VSS			-5.0	μΑ
lil	"L" input current XIN	VI = VSS		-4		μΑ
VRAM	RAM hold voltage	When clock stopped	2.0		5.5	V

Table 29 Electrical characteristics (2) (Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Currente e l	Devenedar	Test conditio	Test conditions		Limits			
Symbol	Parameter		110	Min.	Тур.	Typ. Max.		
		High-speed mode f(XIN) = 8 MHz f(XCIN) = 32.768 kHz Output transistors "off"			6.8	13	mA	
		High-speed mode f(XIN) = 8 MHz (in WIT state) f(XCIN) = 32.768 kHz Output transistors "off"			1.6		mA	
		f(XIN) = stopped M f(XCIN) = 32.768 kHz Output transistors "off"	Except M38517F8FP/SP		60	200	μA	
			M38517F8FP/SP		250		μA	
	Low-speed mode f(XIN) = stopped	Except M38517F8FP/SP		20	40	μΑ		
	f(XCIN) = 32.768 kHz (in WIT state) Output transistors "off"	M38517F8FP/SP		70		μA		
Icc	Power source current	f(XIN) = stopped	Except M38517F8FP/SP		20	55	μΑ	
		f(XCIN) = 32.768 kHz Output transistors "off"	M38517F8FP/SP		150		μA	
		Low-speed mode (Vcc = 3 V) f(XIN) = stopped	Except M38517F8FP/SP		5.0	10.0	μΑ	
		f(XCIN) = 32.768 kHz (in WIT state) Output transistors "off"	M38517F8FP/SP		20		μA	
		Middle-speed mode f(XIN) = 8 MHz f(XCIN) = stopped Output transistors "off"			4.0	7.0	mA	
	Middle-speed mode f(XIN) = 8 MHz (in WIT state) f(XCIN) = stopped Output transistors "off"			1.5		mA		
		Increment when A-D conversion f(XIN) = 8 MHz	on is executed		800		μΑ	
		All oscillation stopped (in STP state)	Ta = 25 °C		0.1	1.0	μA	
		Output transistors "off"	Ta = 85 °C			10	μA	

Table 30 Electrical characteristics (3)(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

A-D converter characteristics

Table 31 A-D converter characteristics

(Vcc = 2.7 to 5.5 V, Vss = AVss = 0 V, Ta = -20 to 85 °C, f(X IN) = 8 MHz, unless otherwise noted)

Current of	Parameter		Test conditions		Limits		Unit
Symbol	Parameter		Test conditions	Min.	Тур.	Max.	Unit
-	Resolution					10	bit
-	Absolute accuracy (excluding quantiza	Absolute accuracy (excluding quantization error)				±4	LSB
tCONV	Conversion time		High-speed mode, Middle-speed mode			61	$tc(\phi)$
			Low-speed mode		40		μs
RLADDER	Ladder resistor				35		kΩ
IVREF	Reference power source input current	VREF "on"	Vref = 5.0 V	50	150	200	μA
		VREF "off"				5.0	
li(AD)	A-D port input current				0.5	5.0	μA



Timing requirements

Table 32 Timing requirements (1)

(Vcc = 4.0 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Curren el	Desemptor		Limits		Unit XIN cycle ns ns ns ns ns ns ns ns ns ns ns ns ns
Symbol	Parameter	Min.	Тур.	Max.	
tw(RESET)	Reset input "L" pulse width	20			XIN cycle
tC(XIN)	External clock input cycle time	125			ns
twh(Xin)	External clock input "H" pulse width	50			ns
twL(XIN)	External clock input "L" pulse width	50			ns
tc(CNTR)	CNTR0, CNTR1 input cycle time	200			ns
twh(CNTR)	CNTR0, CNTR1 input "H" pulse width	80			ns
twL(CNTR)	CNTR0, CNTR1 input "L" pulse width	80			ns
twн(INT)	INTo to INT3 input "H" pulse width	80			ns
tw∟(INT)	INTo to INT3 input "L" pulse width	80			ns
tC(SCLK1)	Serial I/O1 clock input cycle time (Note)	800			ns
tWH(SCLK1)	Serial I/O1 clock input "H" pulse width (Note)	370			ns
tWL(SCLK1)	Serial I/O1 clock input "L" pulse width (Note)	370			ns
tsu(RxD-SCLK1)	Serial I/O1 input setup time	220			ns
th(SCLK1-RxD)	Serial I/O1 input hold time	100			ns
tC(SCLK2)	Serial I/O2 clock input cycle time	1000			ns
tWH(SCLK2)	Serial I/O2 clock input "H" pulse width	400			ns
tWL(SCLK2)	Serial I/O2 clock input "L" pulse width	400			ns
tsu(SIN2-SCLK2)	Serial I/O2 clock input setup time	200			ns
th(SCLK2-SIN2)	Serial I/O2 clock input hold time	200			ns

Note : When $f(X_{IN}) = 8$ MHz and bit 6 of address 001A16 is "1" (clock synchronous). Divide this value by four when $f(X_{IN}) = 8$ MHz and bit 6 of address 001A16 is "0" (UART).

Table 33 Timing requirements (2)

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Cumhal	Devemeter		Limits		Unit
Symbol	Parameter	Min.	Тур.	Max.	Unit
tw(RESET)	Reset input "L" pulse width	20			XIN cycle
tC(XIN)	External clock input cycle time	250			ns
twh(XIN)	External clock input "H" pulse width	100			ns
twL(XIN)	External clock input "L" pulse width	100			ns
tc(CNTR)	CNTR0, CNTR1 input cycle time	500			ns
twh(CNTR)	CNTR0, CNTR1 input "H" pulse width	230			ns
twL(CNTR)	CNTR0, CNTR1 input "L" pulse width	230			ns
twн(INT)	INTo to INT3 input "H" pulse width	230			ns
tw∟(INT)	INTo to INT3 input "L" pulse width	230			ns
tC(SCLK1)	Serial I/O1 clock input cycle time (Note)	2000			ns
tWH(SCLK1)	Serial I/O1 clock input "H" pulse width (Note)	950			ns
tWL(SCLK1)	Serial I/O1 clock input "L" pulse width (Note)	950			ns
tsu(RxD-SCLK1)	Serial I/O1 input setup time	400			ns
th(SCLK1-RxD)	Serial I/O1 input hold time	200			ns
tC(SCLK2)	Serial I/O2 clock input cycle time	2000			ns
tWH(SCLK2)	Serial I/O2 clock input "H" pulse width	950			ns
tWL(SCLK2)	Serial I/O2 clock input "L" pulse width	950			ns
tsu(SIN2-SCLK2)	Serial I/O2 clock input setup time	400			ns
th(SCLK2-SIN2)	Serial I/O2 clock input hold time	300			ns

Note : When $f(X_{IN}) = 4 \text{ MHz}$ and bit 6 of address 001A16 is "1" (clock synchronous).

Divide this value by four when f(XIN) = 4 MHz and bit 6 of address 001A16 is "0" (UART).

Switching characteristics

Table 34 Switching characteristics (1)

(Vcc = 4.0 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Parameter	Toot conditions	Limits			Unit
		Test conditions	Min.	Тур.	Max.	Unit
tWH (SCLK1)	Serial I/O1 clock output "H" pulse width		tC(SCLK1)/2-30			ns
tWL (SCLK1)	Serial I/O1 clock output "L" pulse width	Fig. 79	tC(SCLK1)/2-30			ns
td (SCLK1-TXD)	Serial I/O1 output delay time (Note 1)				140	ns
tv (SCLK1-TXD)	Serial I/O1 output valid time (Note 1)		-30			ns
tr (SCLK1)	Serial I/O1 clock output rising time				30	ns
tf (SCLK1)	Serial I/O1 clock output falling time				30	ns
tWH (SCLK2)	Serial I/O2 clock output "H" pulse width		tC(SCLK2)/2-160			ns
tWL (SCLK2)	Serial I/O2 clock output "L" pulse width		tc(Sclk2)/2-160			ns
td (SCLK2-SOUT2)	Serial I/O2 output delay time (Note 2)				200	ns
tv (SCLK2-SOUT2)	Serial I/O2 output valid time (Note 2)		0			ns
tf (SCLK2)	Serial I/O2 clock output falling time				30	ns
tr (CMOS)	CMOS output rising time (Note 3)	7		10	30	ns
tf (CMOS)	CMOS output falling time (Note 3)			10	30	ns

Notes 1: When the P25/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is "0".

2: When the P01/SOUT2 and P02/SCLK2 P-channel output disable bit of the Serial I/O2 control register 1 (bit 7 of address 001516) is "0". 3: The XOUT pin is excluded.

Table 35 Switching characteristics (2)

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Parameter	To at a smallting a	Limits			Unit
		Test conditions	Min.	Тур.	Max.	Unit
twh (Sclk1)	Serial I/O1 clock output "H" pulse width		tC(SCLK1)/2-50			ns
tWL (SCLK1)	Serial I/O1 clock output "L" pulse width	Fig. 79	tc(Sclk1)/2-50			ns
td (SCLK1-TXD)	Serial I/O1 output delay time (Note 1)				350	ns
tv (SCLK1-TXD)	Serial I/O1 output valid time (Note 1)		-30			ns
tr (SCLK1)	Serial I/O1 clock output rising time]			50	ns
tf (SCLK1)	Serial I/O1 clock output falling time				50	ns
tWH (SCLK2)	Serial I/O2 clock output "H" pulse width		tC(SCLK2)/2-240			ns
tWL (SCLK2)	Serial I/O2 clock output "L" pulse width		tc(Sclk2)/2-240			ns
td (SCLK2-SOUT2)	Serial I/O2 output delay time (Note 2)				400	ns
tv (SCLK2-SOUT2)	Serial I/O2 output valid time (Note 2)		0			ns
tf (SCLK2)	Serial I/O2 clock output falling time				50	ns
tr (CMOS)	CMOS output rising time (Note 3)			20	50	ns
tf (CMOS)	CMOS output falling time (Note 3)]		20	50	ns

Notes 1: When the P25/TXD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is "0".

2: When the P01/SOUT2 and P02/SCLK2 P-channel output disable bit of the Serial I/O2 control register 1 (bit 7 of address 001516) is "0". 3: The XOUT pin is excluded.



MULTI-MASTER I²C-BUS BUS LINE CHARACTERISTICS

Table 36 Multi-master I²C-BUS bus line characteristics

Symbol	Parameter		Standard clock mode		High-speed clock mode		
		Test conditions	Min.	Max.	Min.	Max.	Unit
tBUF	Bus free time		4.7		1.3		μs
thd;sta	Hold time for START condition		4.0		0.6		μs
tLOW	Hold time for ScL clock = "0"		4.7		1.3		μs
tR	Rising time of both SCL and SDA signals			1000	20+0.1Cb	300	ns
thd;dat	Data hold time	Fig. 80	0		0	0.9	μs
thigh	Hold time for ScL clock = "1"	- Fig. 60	4.0		0.6		μs
tF	Falling time of both ScL and SDA signals			300	20+0.1Cb	300	ns
tsu;dat	Data setup time		250		100		ns
tsu;sta	Setup time for repeated START condition		4.7		0.6		μs
tsu;sto	Setup time for STOP condition		4.0		0.6		μs

Note: C_b = total capacitance of 1 bus line

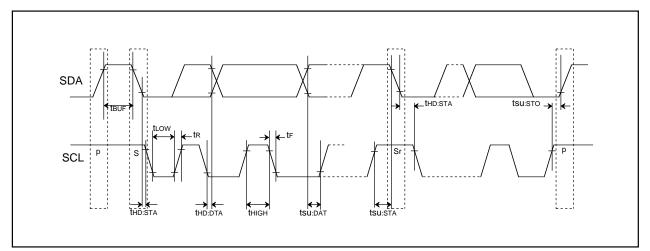
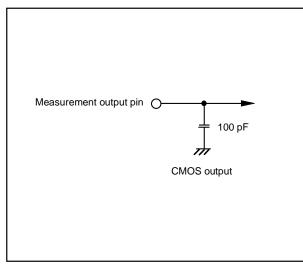


Fig. 78 Timing diagram of multi-master I²C-BUS

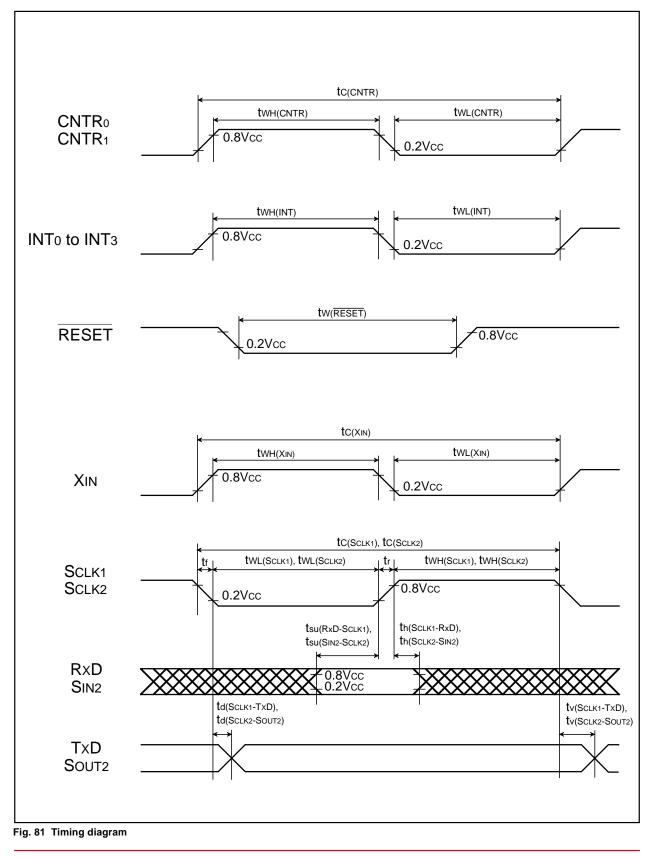




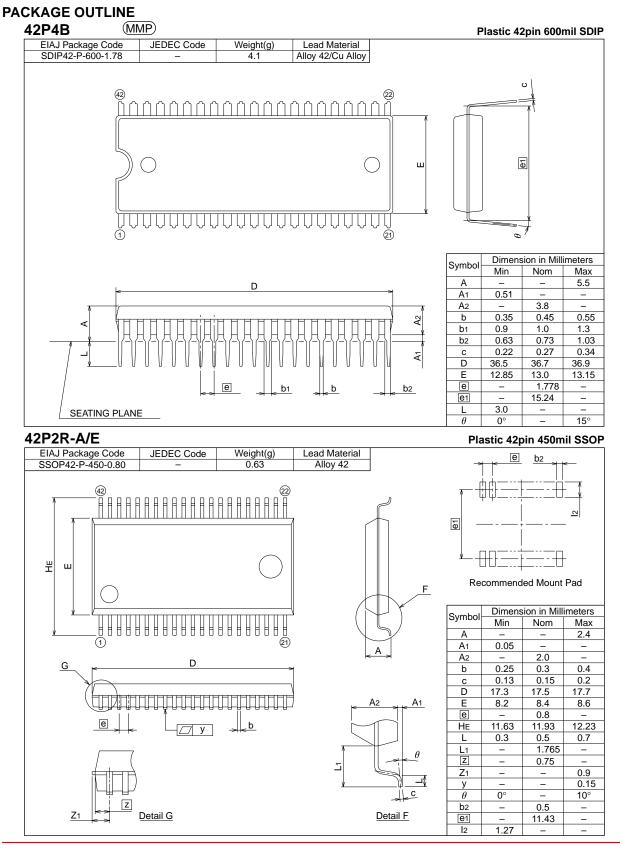
Measurement output pin $figure{}{}$ 1 kΩ $figure{}{}$ 100 pF $figure{}{}$ N-channnel open-drain



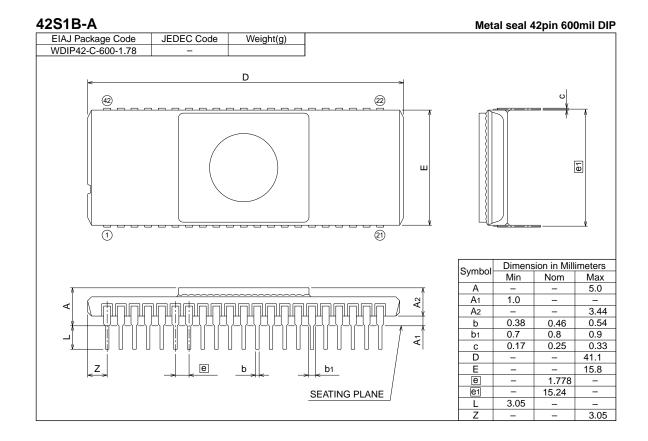
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REVISION HISTORY

3851 Group (built-in 24 KB or more ROM) Data Sheet

Rev.	Date		Description		
		Page	Summary		
1.00	Jul. 26, 2002	_	First edition issued		
1.01	Oct. 15, 2003		•Mitsubishi, Mitsubishi Electric Corporation \rightarrow Renesas Technology Corporation •ScLK \rightarrow ScLK1		
		1 5	•Multi-master I ² C-BUS interface (option) \rightarrow •Multi-master I ² C-BUS interface Fig.4 Memory expansion plan		
		14-15	Under development M38517M8/F8 → Mass production M38517M8/F8 "SDA input", "SCL input" → → → → "Serial I/O1 input" → → → →		
		15	(12)Port P26 External clock input \rightarrow Serial I/O1 external clock input (13)Port P27 Serial ready output \rightarrow Serial I/O1 ready output		
		17	 Interrupt occur by 17 sources among 17 sources seven external → Interrupt occur by 17 sources : seven external 		
		18	•address 3A16, address 2316 \rightarrow address 003A16, address 002316 Table 8 Interrupt vector addresses and priority Serial I/O1 reception, Serial I/O transmission : Remarks Valid when serial I/O1 is selected \rightarrow Valid when serial I/O is selected		
		22	Fig.18 Block diagram of clock synchronous serial I/O P27/SRDY1 \rightarrow P27/CNTR0/SRDY1		
		 MITSUBISHI ELECTRIC CORPORATION'S → Renesas Technology Corporation's Bit 6: SDA/SCL pin selection bit → Bit 6: SDA/SCL pin selection bit (TSEL) Bit 7: I²C-BUS interface pin input level selection bit Bit 7: I²C-BUS interface pin input level selection bit 			
		77	 → Bit 7: I²C-BUS interface pin input level selection bit (TISS) "Mitsubishi MCU Technical Information" Homepage (http://www.infomicom.maec.co.jp/indexe.htm) → "Renesas Technology" Homepage Rom ordering (http://www.renesas.com/eng/rom) 		
		79	Table 26 Recommended operating conditions (1) Limits Symbol Parameter Limits Min. Typ. Max. Unit		
			VIH "H" input voltage (when I ² C-BUS input level is selected) 0.7Vcc Vcc V SDA2, SCL2 SDA1, SCL1 0.7Vcc 5.8 V VIH "H" input voltage (when SMBUS input level is selected) 1.4 Vcc V SDA2, SCL2 SDA1, SCL1 1.4 Vcc V I I 5.8 V		
		↓			
			Symbol Parameter Limits Unit VIH "H" input voltage (when I ² C-BUS input level is selected) [SDA1, SCL1 0.7Vcc 5.8 V SDA2, SCL2 0.7Vcc VCC VCC V VIH "H" input voltage (when SMBUS input level is selected) [SDA1, SCL1 1.4 5.8 V		
		81	Table 29 Electrical characteristics (2) VT+-VT- Hysterisis RxD, SCLK \rightarrow RxD, SCLK1, SIN2, SCLK2		

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